Sitronix

ST7549

68 x 102 Dot Matrix LCD Controller/Driver

1. INTRODUCTION

The ST7549 is a driver & controller LSI for graphic dot-matrix liquid crystal display systems. It contains 102 segment and 67 common with 1 ICOM driver circuits. This chip is connected directly to a microprocessor, accepts 3-line or 4-line serial peripheral interface (SPI) I^2C interface or 8-bit parallel interface, display data can stores in an on-chip display data RAM of 68 x 102 bits. It performs display data RAM read/write operation with no external operating clock to minimize power consumption. In addition, because it contains power supply circuits to drive liquid crystal, it is possible to make a display system with the fewest components.

2. FEATURES

Single-chip LCD controller & driver

Driver Output Circuits

102 segment / 67 common+1 ICON common (1/68 duty)

102 segment / 32 common+1 ICON common (1/33 duty)

102 segment / 16 common+1 ICON common (1/17 duty)

(1/33 duty and 1/17 duty are under partial screen mode)

On-chip Display Data Ram

- Capacity: 68X102=6,936 bits

Microprocessor Interface

- 8-bit parallel bi-directional interface with 6800-series or 8080-series

- 4-line SPI (serial peripheral interface) available (only write operation)

- 3-line SPI (serial peripheral interface) available

- I^2C (Inter-Integrated Circuit) Interface

On-chip Low Power Analog Circuit

- Generation of LCD supply voltage (externally

Vout voltage supply is possible)

- Generation of intermediate LCD bias voltages

- Oscillator requires no external components (external clock also possible)

- Voltage converter (X2,X3,X4,X5)

- Voltage regulator(temperature gradient -0.05%/$^\circ$C)

- Voltage follower

- On-chip electronic contrast control function (255 steps)

External RESB (reset) pin

Logic supply voltage range

- V_{DD1} -V_{SS} : 1.7 to 3.3V

- V_{DD2} -V_{SS} : 2.4 to 3.3V

Display supply voltage range Vout -V_{SS}

- 4.5 to 13V

Temperature range: -40 to +85 degree

ST7549	6800 , 8080 , 4-Line , 3-Line interface (without I^2C interface)	ST
ST7549i	I^2C interface	I²C BUS

3. ST7549 Pad Arrangement (COG)

Chip Size: 8,200 um × 1020 um

Bump Pitch:

PAD NO 1 ~ 11 , 12 ~ 147 , 207 ~ 230 : 55 um ;   PAD NO 11 ~ 12 : 56 um ;

PAD NO 148 ~ 216 : max : 175 um , min : 72 um

Bump Size:

PAD NO 188 ~ 193 : 45 (x)um × 60 (y) um   ;

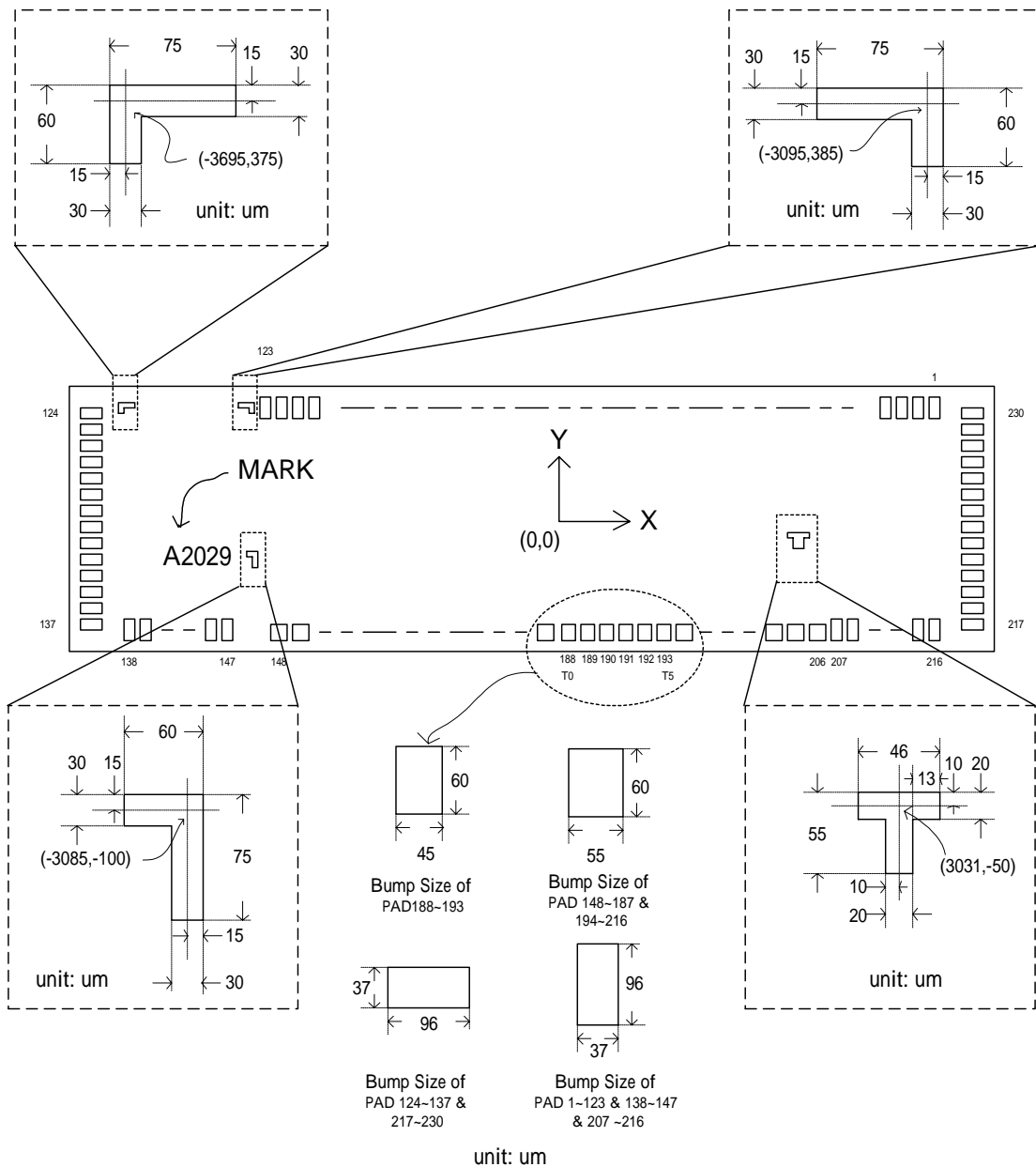**PAD NO 148 ~ 187 , 194 ~ 206 : 55 (x) um × 60 (y) um   ;**

PAD NO 124 ~ 137 , 217 ~ 230: 96 (x) um × 37 (y) um   ;

PAD NO 1 ~ 123 , 138 ~ 147 , 207 ~ 216 :   37 (x) um × 96 (y) um   ;

Bump Height: 17 um

Chip Thickness: 625 um

Bump Size of PAD 188-193

Bump Size of PAD 148-187 & 194-216

Bump Size of PAD 124-137 & 217-230

Bump Size of PAD 1~123 & 138-147 & 207~216

unit : um

Pad Center Coordinates(68 Duty)

PAD NO.	PIN Name	X	Y	PAD NO.	PIN Name	X	Y
1	COM[43]	3677	371	31	SEG[19]	2026	371
2	COM[42]	3622	371	32	SEG[20]	1971	371
3	COM[41]	3567	371	33	SEG[21]	1916	371
4	COM[40]	3512	371	34	SEG[22]	1861	371
5	COM[39]	3457	371	35	SEG[23]	1806	371
6	COM[38]	3402	371	36	SEG[24]	1751	371
7	COM[37]	3347	371	37	SEG[25]	1696	371
8	COM[36]	3292	371	38	SEG[26]	1641	371
9	COM[35]	3237	371	39	SEG[27]	1586	371
10	COM[34]	3182	371	40	SEG[28]	1531	371
11	COM[33]	3127	371	41	SEG[29]	1476	371
12	SEG[0]	3071	371	42	SEG[30]	1421	371
13	SEG[1]	3016	371	43	SEG[31]	1366	371
14	SEG[2]	2961	371	44	SEG[32]	1311	371
15	SEG[3]	2906	371	45	SEG[33]	1256	371
16	SEG[4]	2851	371	46	SEG[34]	1201	371
17	SEG[5]	2796	371	47	SEG[35]	1146	371
18	SEG[6]	2741	371	48	SEG[36]	1091	371
19	SEG[7]	2686	371	49	SEG[37]	1036	371
20	SEG[8]	2631	371	50	SEG[38]	981	371
21	SEG[9]	2576	371	51	SEG[39]	926	371
22	SEG[10]	2521	371	52	SEG[40]	871	371
23	SEG[11]	2466	371	53	SEG[41]	816	371
24	SEG[12]	2411	371	54	SEG[42]	761	371
25	SEG[13]	2356	371	55	SEG[43]	706	371
26	SEG[14]	2301	371	56	SEG[44]	651	371
27	SEG[15]	2246	371	57	SEG[45]	596	371
28	SEG[16]	2191	371	58	SEG[46]	541	371
29	SEG[17]	2136	371	59	SEG[47]	486	371
30	SEG[18]	2081	371	60	SEG[48]	431	371

PAD NO.	PIN Name	X	Y	PAD NO.	PIN Name	X	Y
61	SEG[49]	376	371	91	SEG[79]	-1274	371
62	SEG[50]	321	371	92	SEG[80]	-1329	371
63	SEG[51]	266	371	93	SEG[81]	-1384	371
64	SEG[52]	211	371	94	SEG[82]	-1439	371
65	SEG[53]	156	371	95	SEG[83]	-1494	371
66	SEG[54]	101	371	96	SEG[84]	-1549	371
67	SEG[55]	46	371	97	SEG[85]	-1604	371
68	SEG[56]	-9	371	98	SEG[86]	-1659	371
69	SEG[57]	-64	371	99	SEG[87]	-1714	371
70	SEG[58]	-119	371	100	SEG[88]	-1769	371
71	SEG[59]	-174	371	101	SEG[89]	-1824	371
72	SEG[60]	-229	371	102	SEG[90]	-1879	371
73	SEG[61]	-284	371	103	SEG[91]	-1934	371
74	SEG[62]	-339	371	104	SEG[92]	-1989	371
75	SEG[63]	-394	371	105	SEG[93]	-2044	371
76	SEG[64]	-449	371	106	SEG[94]	-2099	371
77	SEG[65]	-504	371	107	SEG[95]	-2154	371
78	SEG[66]	-559	371	108	SEG[96]	-2209	371
79	SEG[67]	-614	371	109	SEG[97]	-2264	371
80	SEG[68]	-669	371	110	SEG[98]	-2319	371
81	SEG[69]	-724	371	111	SEG[99]	-2374	371
82	SEG[70]	-779	371	112	SEG[100]	-2429	371
83	SEG[71]	-834	371	113	SEG[101]	-2484	371
84	SEG[72]	-889	371	114	COMS	-2540	371
85	SEG[73]	-944	371	115	COM[0]	-2595	371
86	SEG[74]	-999	371	116	COM[1]	-2650	371
87	SEG[75]	-1054	371	117	COM[2]	-2705	371
88	SEG[76]	-1109	371	118	COM[3]	-2760	371
89	SEG[77]	-1164	371	119	COM[4]	-2815	371
90	SEG[78]	-1219	371	120	COM[5]	-2870	371

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PAD NO.	PIN Name	X	Y	PAD NO.	PIN Name	X	Y
121	COM[6]	-2925	371	151	VDD1	-1929	-389
122	COM[7]	-2980	371	152	VDD1	-1856	-389
123	COM[8]	-3035	371	153	VDD1	-1783	-389
124	COM[9]	-3981	352	154	PS0	-1710	-389
125	COM[10]	-3981	297	155	PS1	-1591	-389
126	COM[11]	-3981	242	156	PS2	-1518	-389
127	COM[12]	-3981	187	157	BR	-1399	-389
128	COM[13]	-3981	132	158	VSS	-1326	-389
129	COM[14]	-3981	77	159	T8	-1253	-389
130	COM[15]	-3981	22	160	T9	-1134	-389
131	COM[16]	-3981	-33	161	CP	-1061	-389
132	COM[17]	-3981	-88	162	T10	-942	-389
133	COM[18]	-3981	-143	163	T11	-869	-389
134	COM[19]	-3981	-198	164	VDD2	-766	-389
135	COM[20]	-3981	-253	165	VDD2	-693	-389
136	COM[21]	-3981	-308	166	VDD2	-620	-389
137	COM[22]	-3981	-363	167	VDD2	-547	-389
138	COM[23]	-3678	-371	168	RESB	-410	-389
139	COM[24]	-3623	-371	169	CSB	-291	-389
140	COM[25]	-3568	-371	170	/WR	-218	-389
141	COM[26]	-3513	-371	171	/RD	-99	-389
142	COM[27]	-3458	-371	172	A0	-26	-389
143	COM[28]	-3403	-371	173	VDD1	77	-389
144	COM[29]	-3348	-371	174	D7	150	-389
145	COM[30]	-3293	-371	175	D6	269	-389
146	COM[31]	-3238	-371	176	D5	342	-389
147	COM[32]	-3183	-371	177	D4	461	-389
148	T6	-2194	-389	178	D3	534	-389
149	T7	-2075	-389	179	D2	653	-389
150	VDD1	-2002	-389	180	D1	726	-389

PAD NO.	PIN Name	X	Y	PAD NO.	PIN Name	X	Y
181	D0	845	-389	211	COM[63]	3403	-371
182	OSC	918	-389	212	COM[62]	3458	-371
183	VSS	1021	-389	213	COM[61]	3513	-371
184	VSS	1094	-389	214	COM[60]	3568	-371
185	VSS	1167	-389	215	COM[59]	3623	-371
186	VSS	1240	-389	216	COM[58]	3678	-371
187	VRS	1313	-389	217	COM[57]	3981	-363
188	T0	1385	-389	218	COM[56]	3981	-308
189	T1	1534	-389	219	COM[55]	3981	-253
190	T2	1609	-389	220	COM[54]	3981	-198
191	T3	1784	-389	221	COM[53]	3981	-143
192	T4	1859	-389	222	COM[52]	3981	-88
193	T5	2034	-389	223	COM[51]	3981	-33
194	VSS	2108	-389	224	COM[50]	3981	22
195	VSS	2181	-389	225	COM[49]	3981	77
196	VSS	2254	-389	226	COM[48]	3981	132
197	VSS	2327	-389	227	COM[47]	3981	187
198	VLCDOUT	2415	-389	228	COM[46]	3981	242
199	VLCDOUT	2488	-389	229	COM[45]	3981	297
200	VLCDIN	2561	-389	230	COM[44]	3981	352
201	VLCDIN	2634	-389				
202	V0	2793	-389				
203	V1	2883	-389				
204	V2	2956	-389				
205	V3	3029	-389				
206	V4	3102	-389				
207	COMS	3183	-371				
208	COM[66]	3238	-371				
209	COM[65]	3293	-371				
210	COM[64]	3348	-371				

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4. BLOCK DIAGRAM

Fig.1 block diagram

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5. PINNING DESCRIPTIONS

Pin Name	I/O	Description	No. of Pins
Lcd driver outputs			
SEG0 to SEG101	**O**	LCD segment driver outputs This display data and the M signal control the output voltage of segment driver. | Display data	M (Internal)	Segment drover output voltage	
		Normal display	Reverse display
H	H	V_0	V_2
H	L	V_{SS}	V_3
L	H	V_2	V_0
L	L	V_3	V_{SS}
Power save mode		V_{SS}	V_{SS}		**102**
COM0 to COM66	**O**	LCD column driver outputs This internal scanning data and M signal control the output voltage of common driver. | Display data	M(Internal)	Common drover output voltage	
		Normal display	Reverse display
H	H	V_{SS}	
H	L	V_0	
L	H	V_1	
L	L	V_4	
Power save mode		V_{SS}			**67**
COMS	**O**	Common output for the icons The output signals of two pins are same. When not used, this pin should be left open.	**2**
MICROPROCESSOR INTERFACE			
PS[2:0]	**I**	Microprocessor interface select input pin | PS0	PS1	PS2	State
" L "	" L "	" L "	4 Pin-SPI MPU interface
" L "	" L "	" H "	3 Pin-SPI MPU interface
" L "	" H "	" L "	8080-series parallel MPU interface
" L "	" H "	" H "	6800-series parallel MPU interface
" H "	"H"	" H "	I^2C interface		**3**
CSB	**I**	Chip select input pins Data/instruction I/O is enabled only when CSB is " L ". When chip select is non-active, DB0 to DB7 is high impedance. There is no CSB pin in I^2C interface, so this pin can fix to " H"	**1**
RESB	**I**	Reset input pin When RESB is " L ", initialization is executed.	**1**
A0	**I**	It determines whether the data bits are data or a command. A0=" H ": Indicates that D0 to D7 are display data. A0=" L ": Indicates that D0 to D7 are control data. There is no A0 pin in three line or I^2C interface, so this pin can fix to " H"	**1**

/WR(R/W)	I	Read/Write execution control pin (PS[0:1]=[L:H]) <table><tr><td>PS2</td><td>MPU type</td><td>/WR(R/W)</td><td>Description</td></tr><tr><td>H</td><td>6800-series</td><td>R/W</td><td>Read/Write control input pin R/W=" H ": read R/W=" L": write</td></tr><tr><td>L</td><td>8080-series</td><td>/WR</td><td>Write enable clock input pin The data on D0 to D7 are latched at the rising edge of the /WR signal</td></tr></table> When in the serial interface must fix to " H"	1
/RD (E)	I	Read/Write execution control pin (PS[0:1]=[L:H]) <table><tr><td>PS2</td><td>MPU Type</td><td>/RD (E)</td><td>Description</td></tr><tr><td>H</td><td>6800-series</td><td>E</td><td>Read/Write control input pin R/W=" H ": When E is " H ", D0 to D7 are in an output status. R/W=" L ": The data on D0 to D7 are latched at the falling edge of the E signal.</td></tr><tr><td>L</td><td>8080-series</td><td>/RD</td><td>Read enable clock input pin When /RD is " L ", D0 to D7 are in an output status.</td></tr></table> When in the serial interface must fix to " H"	1
D7 to D4 D1 to D3 (SDA) D0(SCLK)	I/O	**When using 8-bit parallel interface : 6800 . 8080** 8-bit bi-directional data bus that is connected to the standard 8-bit microprocessor data bus. When chip select is not active, D0 to D7 is high impedance. **When using serial interface: 4-LINE** D0: serial input clock (SCLK) D1,D2, D3 : serial input data (SDA), must be connected together D4, D5, D6, D7 : must fix to " H" When chip select is not active, D0 to D7 is high impedance. **When using serial interface: 3-LINE** D0 : serial input clock (SCLK) D1 : serial input data (SDA_IN) D2, D3 : serial data output for read ID function(SDA_OUT) D4 : ID1 ,When connect to VSS, ID1=0;connect to VDD,ID1=1 D5 : ID2 ,When connect to VSS, ID2=0;connect to VDD,ID2=1 D6 : ID3 ,When connect to VSS, ID3=0;connect to VDD,ID3=1 D7 : ID4 ,When connect to VSS, ID4=0;connect to VDD,ID4=1 **Suggest D1~D3 be connected together;** **Suggest D4~D7(ID1~ID4) be connected to VDD if not used** When chip select is not active, D0 to D7 is high impedance.	8

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D7 to D6 (SA) D5 to D4(X) D3 to D2 (SDA_OUT) D1 (SDA_IN) D0 (SCLK)		**When using I²C interface** D0: serial clock input (SCLK) D1: serial input data (SDA_IN) D2, D3: (SDA_OUT) serial data acknowledge for the I²C interface. By connecting SDA_OUT to SDA_IN externally, the SDA line becomes fully I²C interface compatible. Having the acknowledge output separated from the serial data line is advantageous in chip on glass (COG) applications. In COG application where the track resistance from the SDA_OUT pad to the system SDA line can be significant, a potential divider is generated by the bus pull-up resistor and the ITO track resistance. It is possible the during the acknowledge cycle the ST7549 will not be able to create a valid logic 0 level. By splitting the SDA_IN input from the SDA_OUT output the device could be used in a mode that ignores the acknowledge bit. In COG applications where the acknowledge cycle is required, it is necessary to minimize the track resistance from the SDA_OUT pad to the system SDA line to guarantee a valid low level. **D1,D2,D3 must be connected together (SDA)** D4, D5: must fix to " H" D6, D7: Is slave address (SA) bit1, 0, must fix to "H" or "L" Chip select input pins "CSB" not used must fix to "H"	
LCD DRIVER SUPPLY			
OSC	**I**	**When the on-chip oscillator is used, this input must be connected to VDD.** An external clock signal, if used, is connected to this input. If the oscillator and external clock are both inhibited by connecting the OSC pin to VSS the display is not clocked and may be left in a DC state. To avoid this, the chip should always be put into Power Down Mode before stopping the clock.	**1**
Power Supply Pins			
V_{SS}	**Power Supply**	Ground.	**9**
V_{DD1}	**Power Supply**	Digital Supply voltage:1.7V~3.3V The 2 supply rails V_{DD1} and V_{DD2} could be connected together. If Digital Option pin is high, must be this level	**5**
V_{DD2}	**Power Supply**	Analog Supply voltage:2.4V~3.3V The 2 supply rails V_{DD1} and V_{DD2} could be connected together.	**4**
V_{LCDIN}	**Power Supply**	If the internal voltage generator is used, the V_{LCDIN} & V_{LCDOUT} must be connected together. An external supply voltage can be supplied using the V_{LCDIN} pad. This pad is for external multiple voltage input. In this case, VLCDOUT has to be left open,	**2**
V_{LCDOUT}	**Power Supply**	If the internal voltage generator is used, the V_{LCDIN} & V_{LCDOUT} must be connected together and series one capacitor to VSS If an external supply is used this pin must be left open.	**2**
V0, V1, V2, V3, V4	**Power Supply**	This is a multi-level power supply for the liquid crystal. $V_{LCDIN} \geq V0 \geq V1 \geq V2 \geq V3 \geq V4 \geq VSS$	**5**

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VRS	Power Supply	Monitor Voltage Regulator level, must be left open.	1
Configuration Pins			
CP	I	Set Booster stages. (VSS=4X;VDD=5X) CP pin set the default value of booster stages after reset , and booster stage can be changed by software instruction	1
BR	I	Set LCD bias ratio. (VSS=1/7;VDD=1/9) BR pin set the default value of bias ratio after reset , and bias ratio can be changed by software instruction	1
Test Pin			
T0~T11	T	T0~T7 must floating T8.T9.T10 must connect to VDD T11 must connect to VSS	10

ST7549 I/O PIN ITO Resister Limitation

PIN Name	ITO Resister
PS[2:0],OSC,CP,BR,T8~T11	No Limitation
T0~T7,VRS, V1 , V2 , V3 , V4	Floating
Vdd1, Vdd2, Vss, Vlcdin , Vlcdout	<100Ω
V0	<500Ω
A0,/WR,/RD,CSB, D0 …D7	<1KΩ
RESB	<10KΩ

6. FUNCTIONS DESCRIPTION

MICROPROCESSOR INTERFACE

Chip Select Input

There is CSB pin for chip selection. The ST7549 can interface with an MPU when CSB is "L". When CSB is "H", these pins are set to any other combination, A0, /RD(E), and /WR(R/W) inputs are disabled and D0 to D7 are to be high impedance. And, in case of serial interface, the internal shift register and the counter are reset.

Parallel / Serial Interface

ST7549 has five types of interface with an MPU, which are three serial and two parallel interfaces. This parallel or serial interface is determined by PS [0:2] pin as shown in table 1.

Table 1. Parallel/Serial Interface Mode

PS0	PS1	PS2	CSB	A0	State
" L "	" L "	" L "	CSB	A0	4 Pin-SPI MPU interface
" L "	" L "	" H "	CSB	" * "	3 Pin-SPI MPU interface
" L "	" H "	" L "	CSB	A0	8080-series parallel MPU interface
" L "	" H "	" H "	CSB	A0	6800-series parallel MPU interface
" H "	" H "	" H "	" * "	" * "	I^{2}C interface

Parallel Interface

The 8-bit bi-directional data bus is used in parallel interface and the type of MPU is selected by PS2 as shown in table 2. The type of data transfer is determined by signals at A0, /RD (E) and /WR(R/W) as shown in table 3.

Table 2. Microprocessor Selection for Parallel Interface

PS0	PS1	PS2	CSB	A0	/RD (E)	/WR (R/W)	DB0 to DB7	MPU bus
L	H	H	CSB	A0	E	R/W	DB0 to DB7	6800-series
L	H	L	CSB	A0	/RD	/WR	DB0 to DB7	8080-series

Table 3. Parallel Data Transfer

Common	6800-series		8080-series		
A0	E (/RD)	R/W (/WR)	/RD (E)	/WR (R/W)	Description
H	H	H	L	H	Display data read out
H	H	L	H	L	Display data write
L	H	H	L	H	Register status read
L	H	L	H	L	Writes to internal register (instruction)

NOTE: When /RD (E) pin is always pulled high for 6800-series interface, it can be used CSB for enable signal. In this case, interface data is latched at the rising edge of CSB and the type of data transfer is determined by signals at A0, /WR(R/W) as in case of 6800-series mode.

Serial Interface

Serial Mode	PS0	PS1	PS2	CSB	A0
4-line SPI interface	L	L	L	CSB	Used
3-line SPI interface	L	L	H	CSB	Not Used Fix to "H"
I^{2}C interface	H	H	H	Not Used Fix to "H"	Not Used Fix to "H"

PS0=" L ", PS1=" L ", PS2=" L ": 4-line SPI interface

When the ST7549 is active (CSB="L"), serial data (D1) and serial clock (D0) inputs are enabled. And not active, the internal 8-bit shift register and the 3-bit counter are reset. The display data/command indication may be controlled either via software or the Register Select (A0) Pin, based on the setting of PS[2:0]. When the A0 pin is used , data is display data when A0 is high, and command data when A0 is low. When A0 is not used , the LCD Driver will receive command from MCU by default. If messages on the data pin are data rather than command, MCU should send Data direction command to

control the data direction and then one more command to define the number of data bytes will be write. After these two continuous commands are sending, the following messages will be data rather than command. Serial data can be read on the rising edge of serial clock going into D0 and processed as 8-bit parallel data on the eighth serial clock. And the DDRAM column address pointer will be increased by one automatically. The next bytes after the display data string are handled as command data.
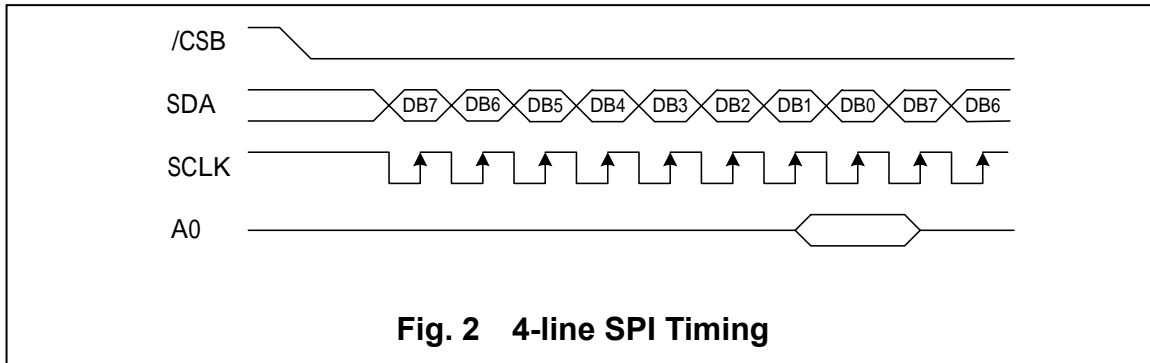
Fig. 2   4-line SPI Timing

PS0=" L ", PS1=" L ", PS2=" H ": 3-line SPI interface
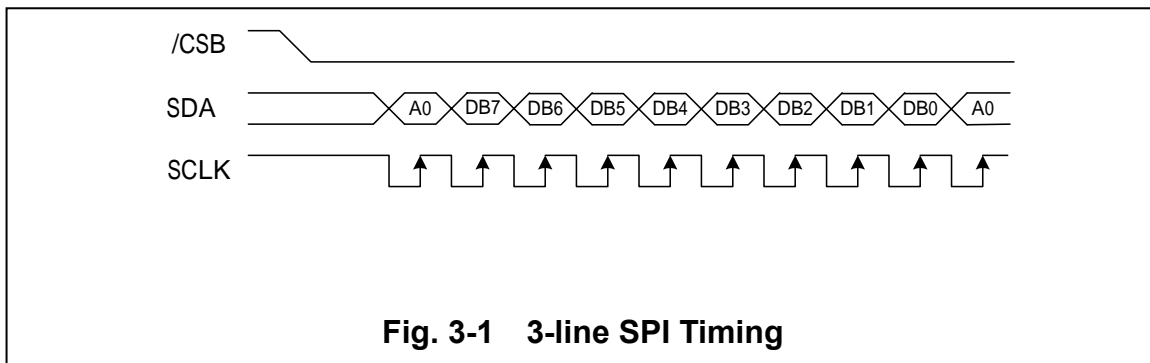
Fig. 3-1   3-line SPI Timing

"D/C": the same as A0
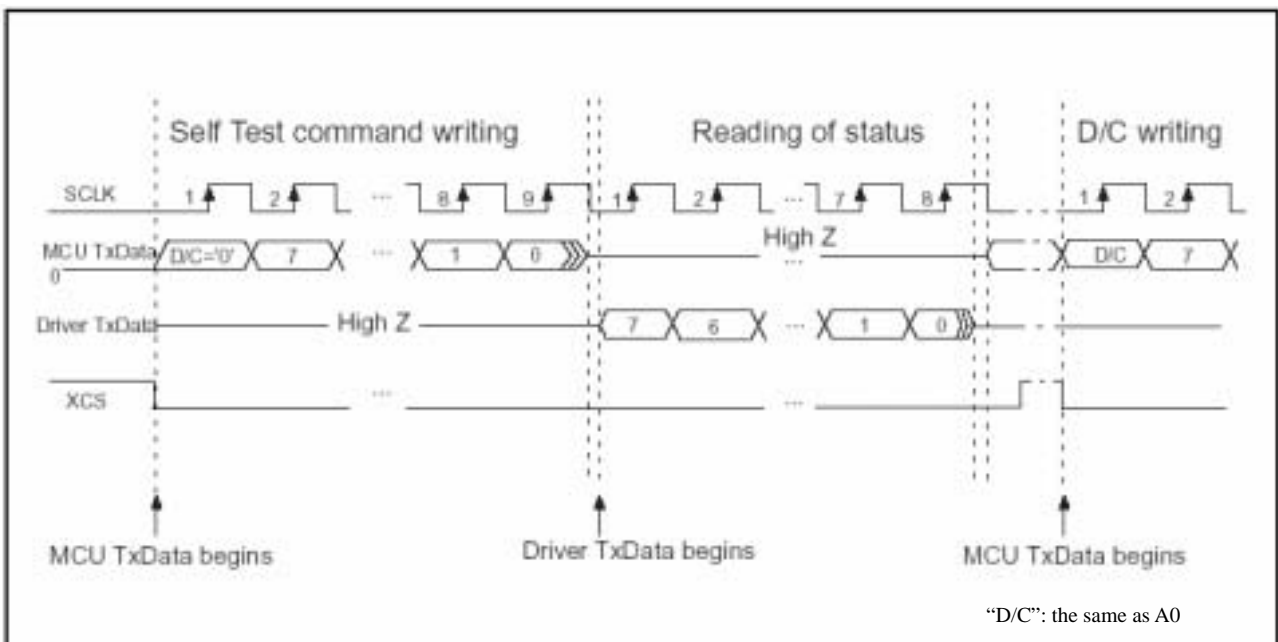
Figure 1-2 shows the timing of reading on one bit of B1....B4

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To access Driver TxData-mode a Self Test command is needed to write to driver. The first bit (A0) is low to indicate next 8-bits are for command. The data is read to the driver on the rising edge of SCLK. After last command bit (bit 0) is read SDA-out becomes active (Low impendence) and MCU is able to read data from driver.

The data is read to 8-bit register in MCU so that the bit which was the object of reading is MSB (D7). The same bit value is the written again to the register 3 times in a row by next 3 rising edges of SCLK. These first 4 bits are MSB. The 4 LSB is written to the register as the complement of 4 MSB by 4 next rising edges of SCLK. The complement function is done by the driver.

This function allows to check if the written data is valid.

After written all 8 bits to the register the Auto Return-block in driver release automatically driver back to the MCU TxData-mode, MCU Txdata line changes from high-z to active low in the falling edge of 8th SCLK pulse. CSB must be set high and low again before A0 writing can continue.
SDA-out and SDA-in line can be short circuited in normal working conditions.

Bit No.	D7(MSB)	D6	D5	D4	D3	D2	D1	D0(LSB)
Status	0 or 1	Bits have same status as MSB			Bits are complement of 4 MSB (D7~D4)			

For example, if D7 (MSB) has status "0" first 4 bits (D7~D4) represent the status of D7 ("0") and next four bits (D3~D0) have status "1" because they represent complement data of D7~D4 (see the figure below)
It is recommended to use below 1 MHz SCLK speed for Driver Tx mode (both self test command writing and reading of status). This guarantees that D7 and D6 status bits are also valid.
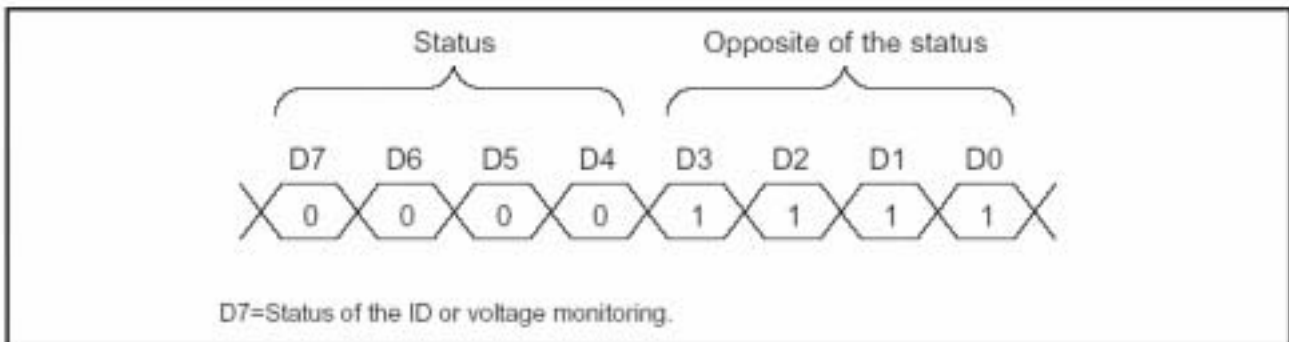
PS0=" H ", PS1=" H ", PS2=" H ": I²C Interface

The I²C interface receives and executes the commands sent via the I²C Interface. It also receives RAM data and sends it to the RAM.

The I²C Interface is for bi-directional, two-line communication between different ICs or modules. The two lines are a Serial Data line (SDA) and a Serial Clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor. Data transfer may be initiated only when the bus is not busy.

BIT TRANSFER

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse because changes in the data line at this time will be interpreted as a control signal. Bit transfer is illustrated in Fig.4.

START AND STOP CONDITIONS

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH is defined as the START condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition (P). The START and STOP conditions are illustrated in Fig.5.

SYSTEM CONFIGURATION

The system configuration is illustrated in Fig.6.
· Transmitter: the device, which sends the data to the bus
· Receiver: the device, which receives the data from the bus
· Master: the device, which initiates a transfer, generates clock signals and terminates a transfer
· Slave: the device addressed by a master
· Multi-Master: more than one master can attempt to control the bus at the same time without corrupting the message
· Arbitration: procedure to ensure that, if more than one master simultaneously tries to control the bus, only one is allowed to do so and the message is not corrupted
· Synchronization: procedure to synchronize the clock signals of two or more devices.

ACKNOWLEDGE

Each byte of eight bits is followed by an acknowledge bit. The acknowledge bit is a HIGH signal put on the bus by the transmitter during which time the master generates an extra acknowledge related clock pulse. A slave receiver which is addressed must generate an acknowledge after the reception of each byte. A master receiver must also generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be taken into consideration). A master receiver must signal an end-of-data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event the transmitter must leave the data line HIGH to enable the master to generate a STOP condition. Acknowledgement on the I²C Interface is illustrated in Fig.7.

Fig .4 Bit transfer

Fig .5 Definition of START and STOP conditions

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Fig .6 System configuration

Fig .7 Acknowledgement on the I²C Interface
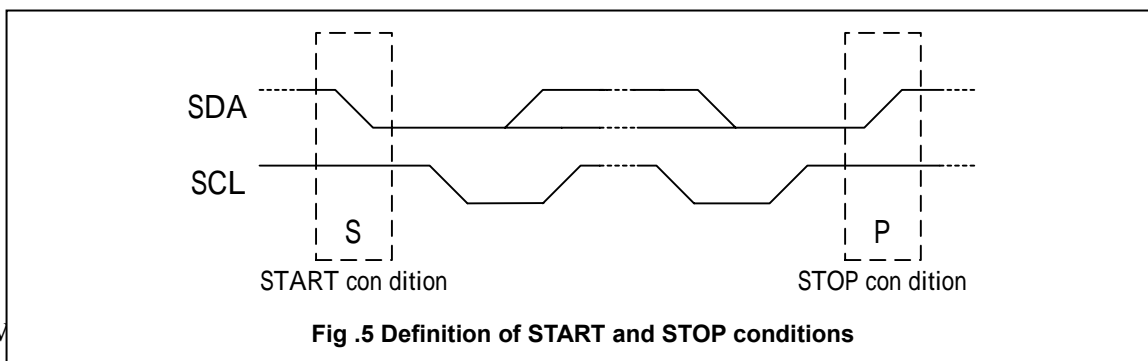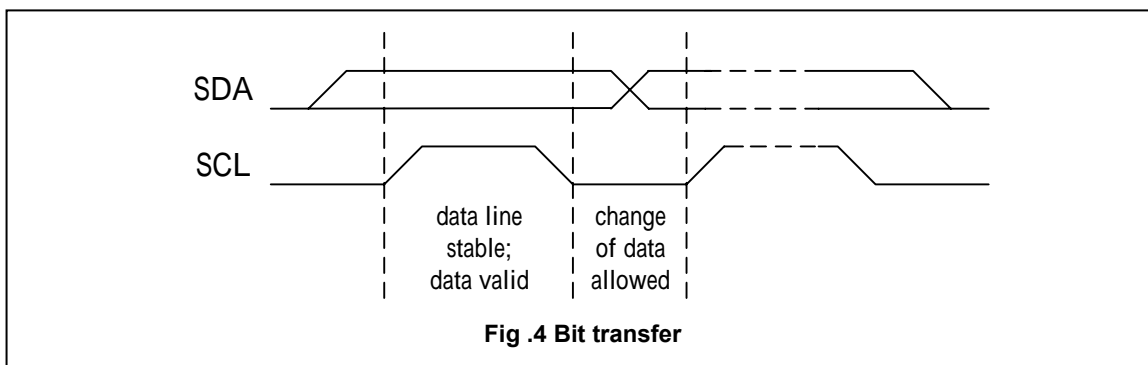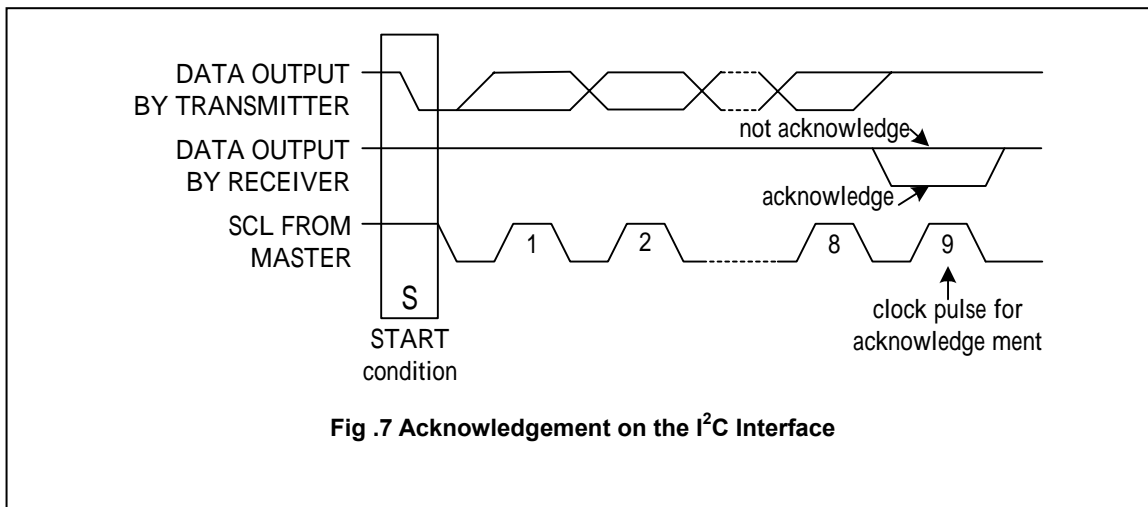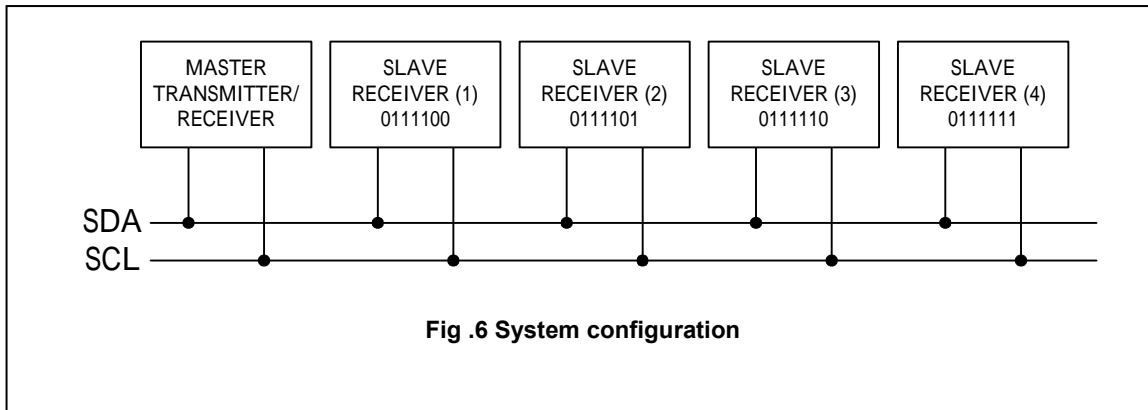
I²C Interface protocol

The ST7549 supports command, data write addressed slaves on the bus.

Before any data is transmitted on the I²C Interface, the device, which should respond, is addressed first. Four 7-bit slave addresses (0111**00**,0111**01**, 0111**10** and 0111**11**) are reserved for the ST7549. The least significant bit of the slave address is set by connecting the input SA0 and SA1 to either logic 0 (or logic 1 (VDD1).

The I²C Interface protocol is illustrated in Fig.8.

The sequence is initiated with a START condition (S) from the I²C Interface master, which is followed by the slave address. All slaves with the corresponding address acknowledge in parallel, all the others will ignore the I²C Interface transfer. After acknowledgement, one or more command words follow which define the status of the addressed slaves.

A command word consists of a control byte, which defines Co and A0, plus a data byte.

The last control byte is tagged with a cleared most significant bit (i.e. the continuation bit Co). After a control byte with a cleared Co bit, only data bytes will follow. The state of the A0 bit defines whether the data byte is interpreted as a command or as RAM data. All addressed slaves on the bus also acknowledge the control and data bytes. After the last control byte, depending on the A0 bit setting; either a series of display data bytes or command data bytes may follow. If the A0 bit is set to logic 1, these display bytes are stored in the display RAM at the address specified by the data pointer. The data pointer is automatically updated and the data is directed to the intended ST7549 device. If the A0 bit of the last control byte is set to logic 0, these command bytes will be decoded and the setting of the device will be changed according to the received commands. Only the addressed slave makes the acknowledgement after each byte. At the end of the transmission the I²C INTERFACE-bus master issues a STOP condition (P).If the R/W bit is set to logic 1 the chip will output data immediately after the slave address if the A0 bit, which was sent during the last write access, is set to logic 0. If no acknowledge is generated by the master after a byte, the driver stops transferring data to the master.

Write mode

acknowledgement
from ST7549

acknowledgement
from ST7549

acknowledgement
from ST7549

acknowledgement
from ST7549

acknowledgement
from ST7549

| S | 0 1 1 1 1 | S A 1 | S A 0 | 0 | A | 1 | A 0 | control byte | A | data byte | A | 0 | A 0 | control byte | A | data byte | A | P |

slave address   R/W

2n>=0bytes
command word

1 byte

n>=0bytes

MSB.....................LSB

Co

Co

| 0 | 1 | 1 | 1 | 1 | S A 1 | S A 0 | R / W |

slave address

| Co | A 0 | 0 | 0 | 0 | 0 | 0 | A |

control byte

Fig .8   IIC Interface protocol

Co	0	Last control byte to be sent. Only a stream of data bytes is allowed to follow.
		This stream may only be terminated by s STOP or RE-START condition.
	1	Another control byte will follow the data byte unless a STOP or RE-START condition is received.

Data Transfer

The ST7549 uses bus holder and internal data bus for data transfer with the MPU. When writing data from the MPU to on-chip RAM, data is automatically transferred from the bus holder to the RAM as shown in figure 9. And when reading data from on-chip RAM to the MPU, the data for the initial read cycle is stored in the bus holder (dummy read) and the MPU reads this stored data from bus holder for the next data read cycle as shown in figure 10. This means that a dummy read cycle must be inserted between each pair of address sets when a sequence of address sets is executed. Therefore, the data of the specified address cannot be output with the read display data instruction right after the address sets, but can be output at the second read of data.

MPU signal

A0

/WR

D0 to D7   N   D(N)   D(N+1)   D(N+2)   D(N+3)

Internal signals

/WR

BUS HOLDER   N   D(N)   D(N+1)   D(N+2)   D(N+3)

COLUMN ADDRESS   N   N+1   N+2   N+3

Fig.9 Write Timing

Fig.10 Read Timing
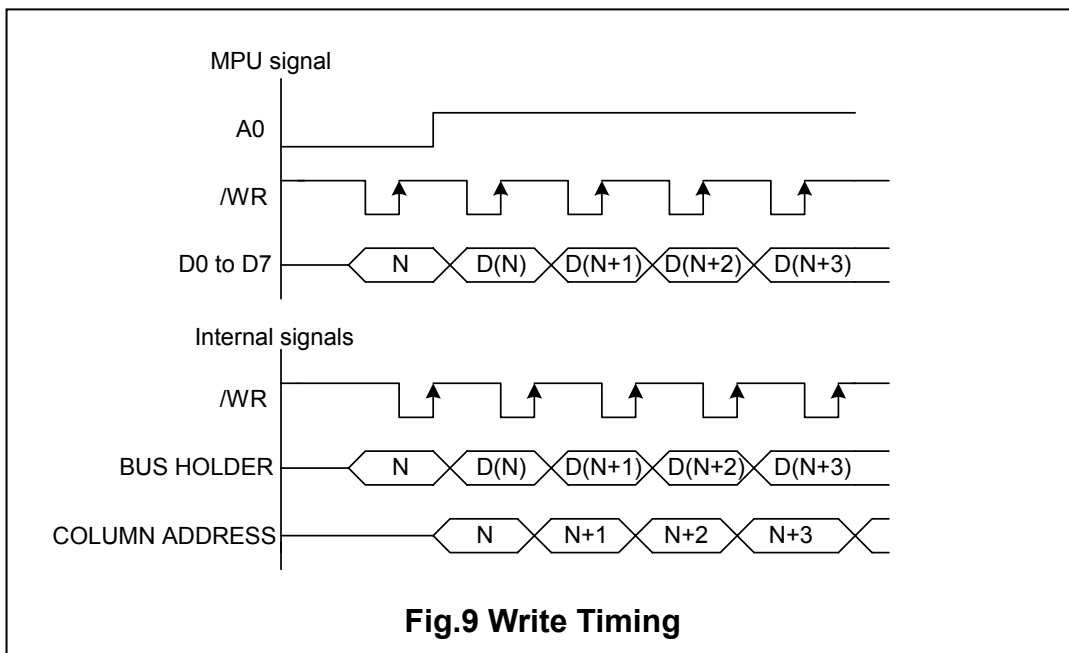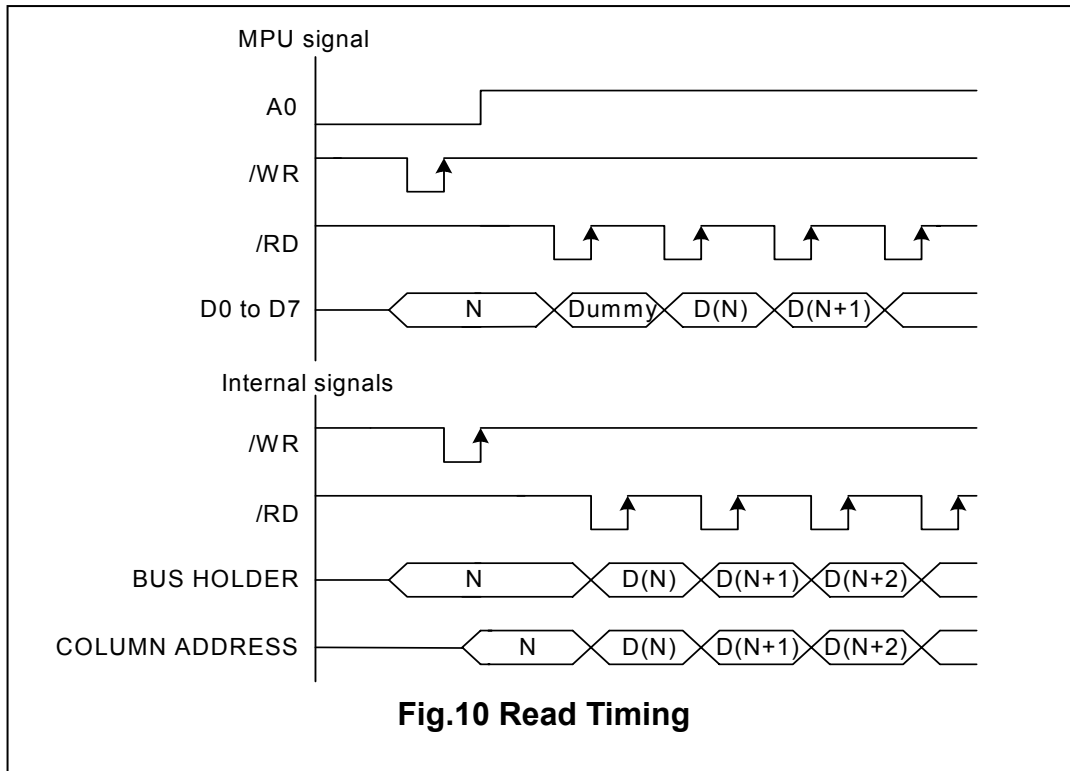
DISPLAY DATA RAM (DDRAM)

The ST7549 contains a 68X102 bit static RAM that stores the display data. The display data RAM store the dot data for the LCD. It has a 68(8 pageX8 bit +1 pageX3 bit +1 pageX1 bit) X 102 . There is a direct correspondence between X-address and column output number. It is 68-row by 102-column addressable array. Each pixel can be selected when the page and column addresses are specified. The 65 rows are divided into 8 pages of 8 lines (0~63 COM) and 8th page with three line (D0 ~D2)(64~ 66 COM) and 9th page with a single line (D0 only)(67 row—COMS (ICON). Data is read from or written to the 8 lines of each page directly through D0 to D7. The display data of D0 to D7 from the microprocessor correspond to the LCD common lines. The microprocessor can read from and write to RAM through the I/O buffer. Since the LCD controller operates independently, data can be written into RAM at the same time as data is being displayed without causing the LCD flicker.

Page Address Circuit

This circuit is for providing a Page Address to Display Data RAM. It incorporates 4-bit Page Address register changed by only the "Set Page" instruction. Page Address 9 is a special RAM area for the icons and display data D0 is only valid.

Line Address Circuit

This circuit assigns DDRAM a Line Address corresponding to the first line (COM0) of the display. Therefore, by setting Line Address repeatedly, it is possible to realize the screen scrolling and page switching without changing the contents of on-chip RAM as shown in figure 10. It incorporates 7-bit Line Address register changed by only the initial display line instruction and 7-bit counter circuit. At the beginning of each LCD frame, the contents of register are copied to the line counter which is increased by CL signal and generates the line address for transferring the 102-bit RAM data to the display data latch circuit. When icon is selected by setting icon page address, display data of icons are not scrolled because the MPU cannot access Line Address of icons.

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Column Address Circuit

Column Address Circuit has an 8-bit preset counter that provides Column Address to the Display Data RAM as shown in figure11. The display data RAM column address is specified by the Column Address Set command. The specified column address is incremented (+1) with each display data read/write command. This allows the MPU display data to be accessed continuously.

Register MX and MY selection instruction makes it possible to invert the relationship between the Column Address and the segment outputs. It is necessary to rewrite the display data on built-in RAM after issuing MX select instruction. Refer to the following figure 12.

SEG Output

SEG Output MX	SEG0 SEG101
"0"	seg0 → Segment Address → seg101
"1"	seg101 ← Segment Address ← seg0

Com Output

SEG Output MY	Com0 Com66	Coms
"0"	com0 → Common Address → com66	Coms
"1"	com66 ← Common Address ← com0	Coms

Duty	MY	Common output pins	
		Com [0:66]	Coms
1/68	0	Com [0:66]	Coms
	1	Com [66:0]	Coms

ADDRESSING

Data is downloaded in bytes into the RAM matrix of ST7549 as indicated in Figs.11, 12, 13, 14. The display RAM has a matrix of 68 by 102 bits. The address pointer addresses the columns. The address ranges are: X 0 to 101 (1100101), Y 0 to 9 (1001) .Addresses outside these ranges are not allowed.

In horizontal addressing mode the X address increments after each byte (see Fig.14). After the last X address (X = 101) X wraps around to 0 and Y increments to address the next row.

After the very last address (X = 101, Y = 9) the address pointers wrap around to address (X = 0, Y =0)

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Data structure

Fig.11 RAM format, addressing , if DO=0

Fig.12 RAM format, addressing, if DO=1

Fig.14 sequence of writing data bytes into RAM with horizontal addressing

Fig.16 Display Data RAM Map (68 COM)
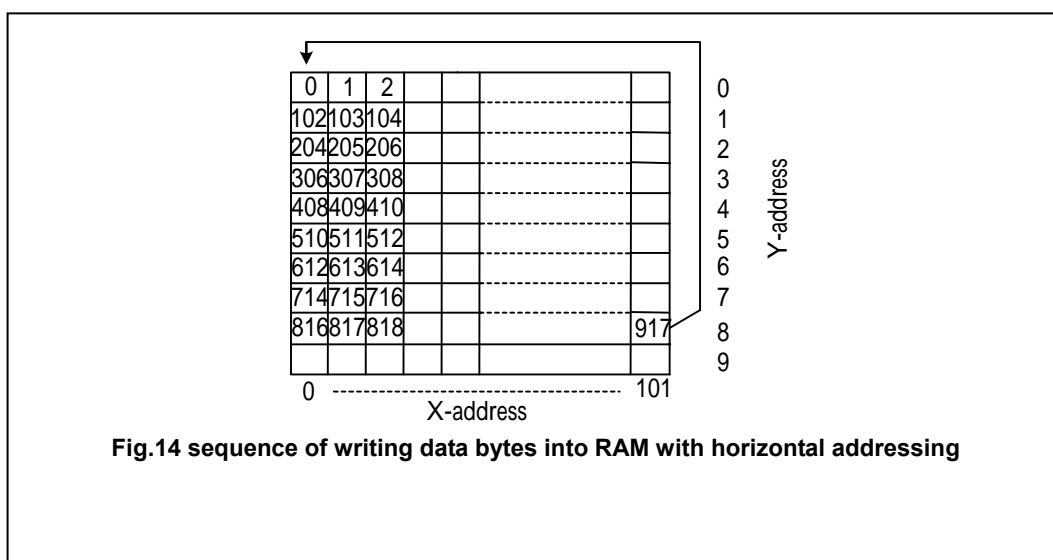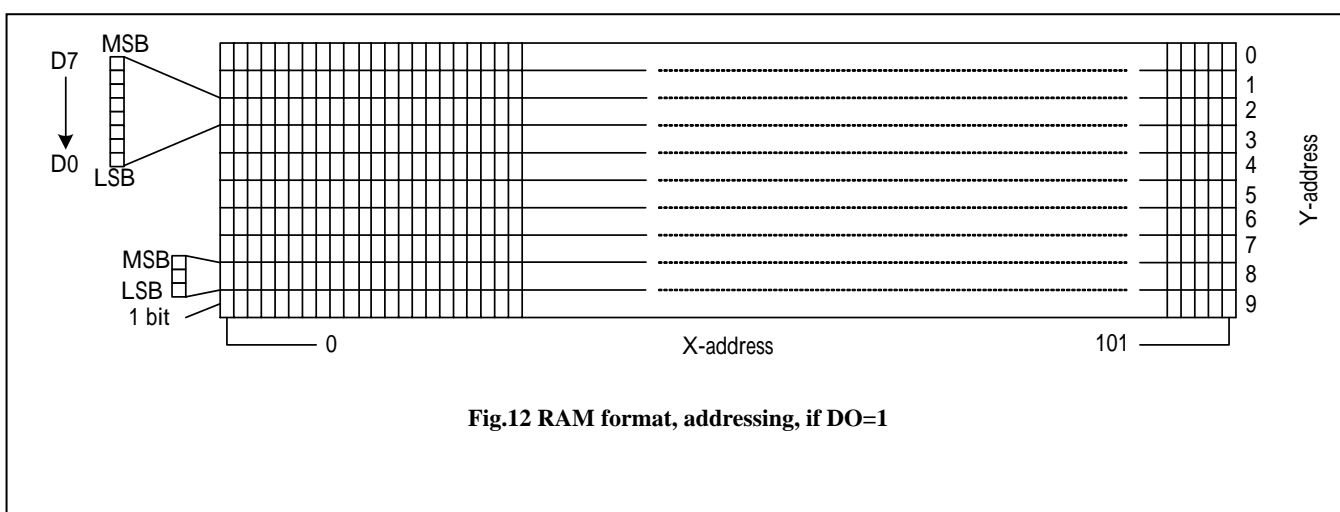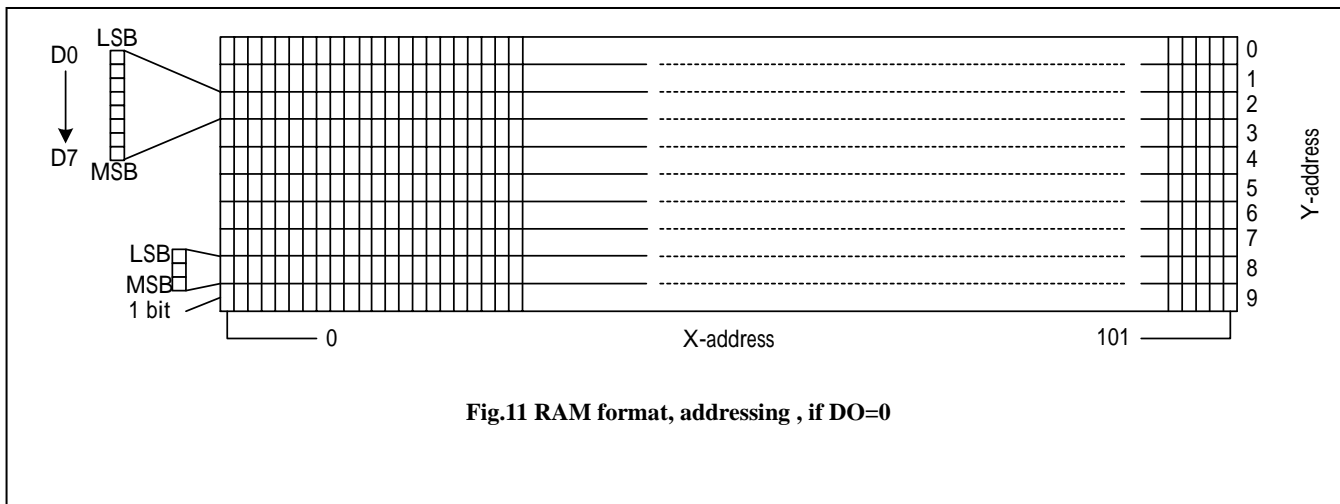
LCD DRIVER CIRCUIT

68-channel common drivers and 102-channel segment drivers configure this driver circuit. This LCD panel driver voltage depends on the combination of display data and M signal.
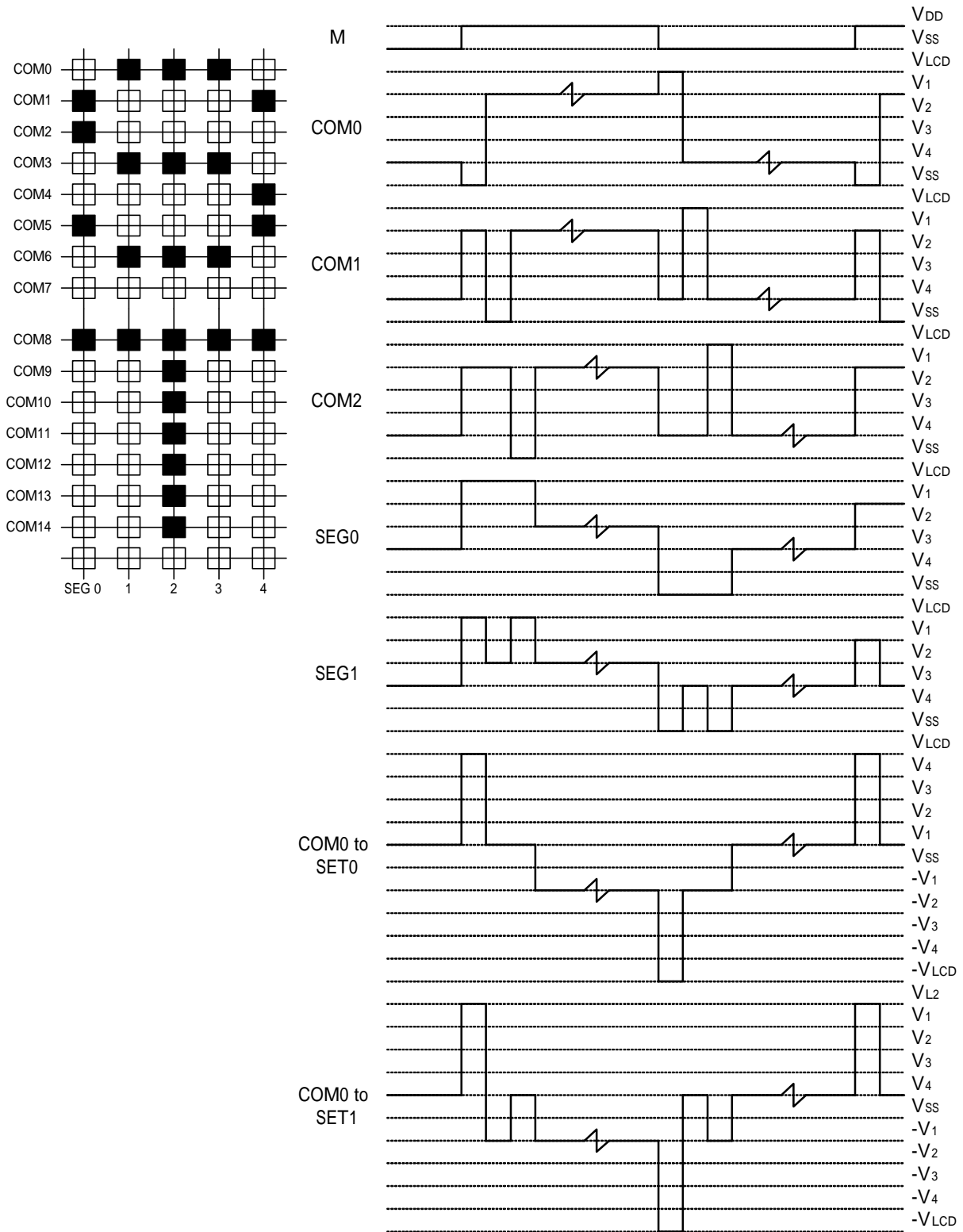
Fig.19 Typical LCD driver waveforms

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Partial Display on LCD

The ST7549 realizes the Partial Display function on LCD with low-duty driving for saving power consumption and showing the various display duty. To show the various display duty on LCD, LCD driving duty and bias are programmable via the instruction. And, built-in power supply circuits are controlled by the instruction for adjusting the LCD driving voltages.
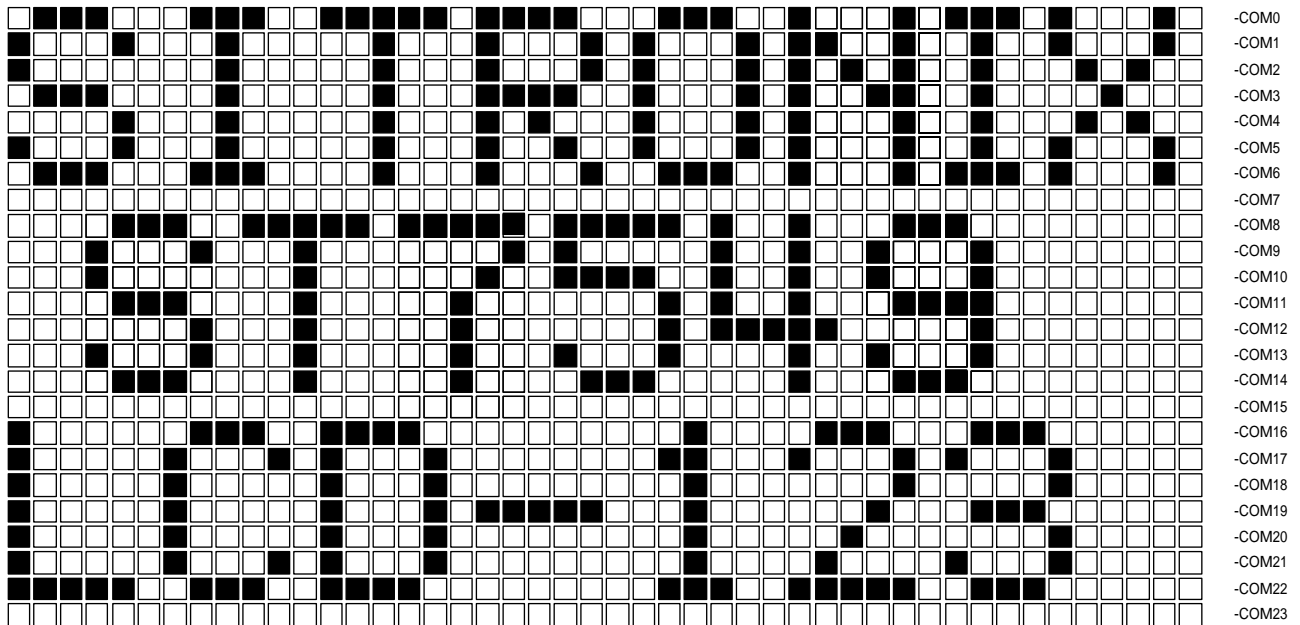
Figure 20.Reference Example for Partial Display
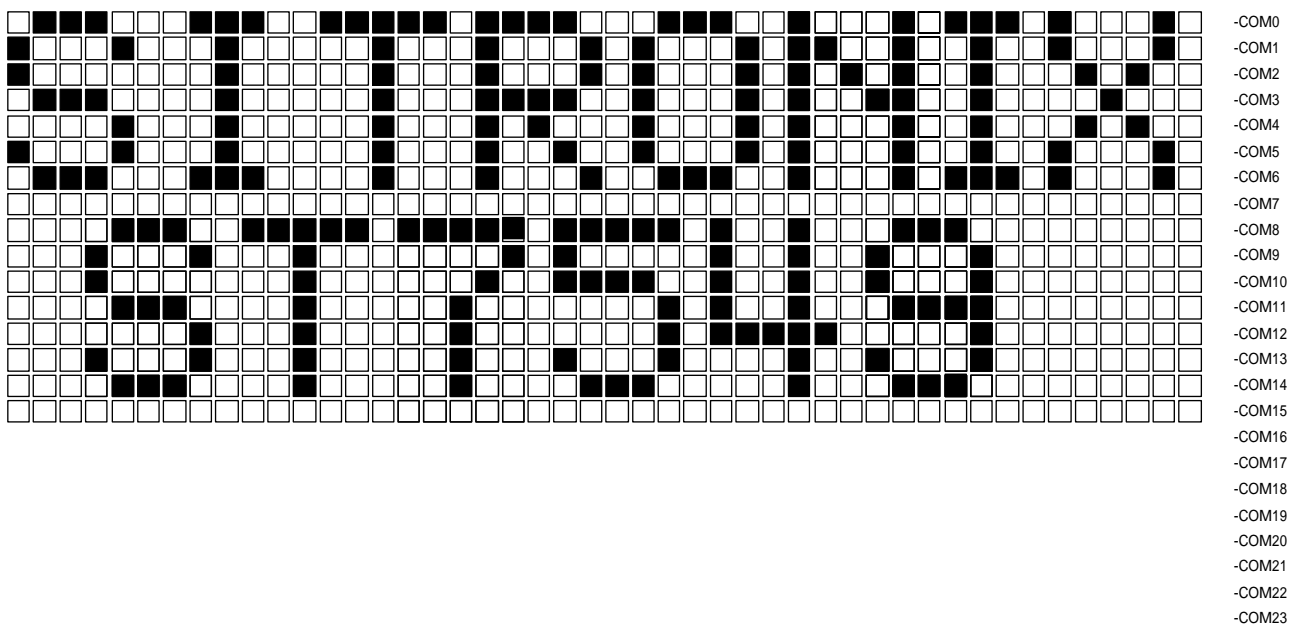
Figure 21.Partial Display (Partial Display Duty=16,initial COM0=0)

ST7549
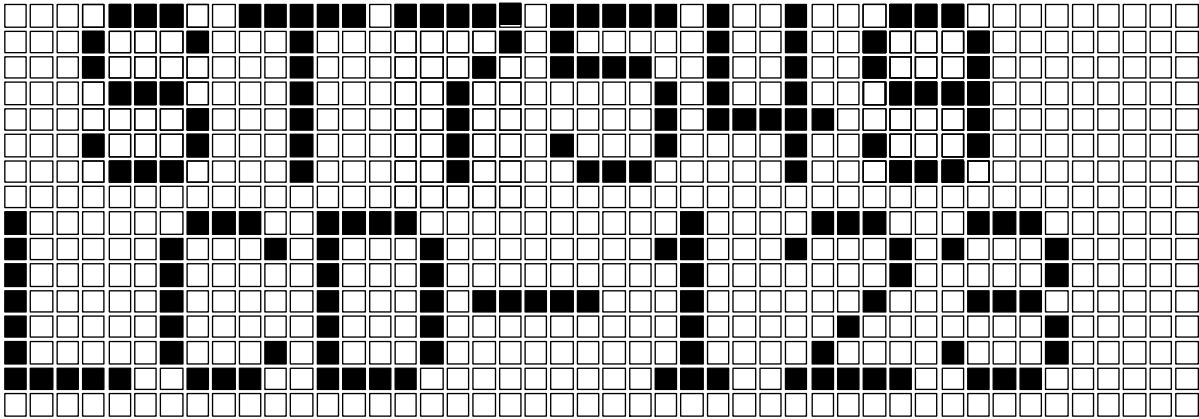
Figure 22.Moving Display (Partial Display Duty=16,Initial COM0=8)

7. RESET CIRCUIT

Setting RESB to "L" or Reset instruction can initialize internal function.

When RESB becomes "L", following procedure is occurred.

Page address: 0

Column address: 0

Display control: Display blank

COM Scan Direction MY: 0

SEG Select Direction MX: 0

DO=0

Oscillator: OFF

N-line inversion register: 0 (disable)

Power down mode (PD = 1)

normal instruction set (H[1:0] = 00)

Display blank (E = D = 0)

Address counter X [6:0] = 0, Y [3:0] = 0

Bias system (BS [2:0] = 0)

VLCD is equal to 0; the HV generator is switched off (VOP [6:0] = 0)

After power-on, RAM data are undefined

While RESB is "L" or reset instruction is executed, no instruction except read status can be accepted. Reset status appears at DB0. After DB0 becomes "L", any instruction can be accepted. RESB must be connected to the reset pin of the MPU, and initialize the MPU and this LSI at the same time. The initialization by RESB is essential before used.

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8. INSTRUCTION TABLE

INSTRUCTION	A0	WR (R/W)	D7	D6	D5	D4	D3	D2	D1	D0	DESCRIPTION
H independent instruction											
NOP	0	0	0	0	0	0	0	0	0	0	No operation
Reserved	0	0	0	0	0	0	0	0	0	1	Do not use
Function set	0	0	0	0	1	MX	MY	PD	H1	H0	Power-down; entry mode; Extended instruction control
Read status byte	0	1	PD	0	0	D	E	MX	MY	DO	Read status byte
Read data	1	1	D_7	D_6	D_5	D_4	D_3	D_2	D_1	D_0	Read data to RAM
Write data	1	0	D_7	D_6	D_5	D_4	D_3	D_2	D_1	D_0	Write data to RAM

INSTRUCTION	A0	WR (R/W)	D7	D6	D5	D4	D3	D2	D1	D0	DESCRIPTION
H[1:0]=[0:0]											
Reserved	0	0	0	0	0	0	0	0	1	X	Do not use
Set V_{LCD} range	0	0	0	0	0	0	0	1	0	PRS	V_{LCD} range L/H select
END	0	0	0	0	0	0	0	1	1	0	Release read/modify/write
Read/modify/write	0	0	0	0	0	0	0	1	1	1	RAM address at R:+0 , W:+1
Display control	0	0	0	0	0	0	1	D	0	E	Sets display configuration
Reserved	0	0	0	0	0	1	0	0	X	X	Do not use
Set Y address of RAM	0	0	0	1	0	0	Y_3	Y_2	Y_1	Y_0	Sets Y address of RAM $0 \le Y \le 9$
Set X address of RAM	0	0	1	X_6	X_5	X_4	X_3	X_2	X_1	X_0	Sets X address of RAM $0 \le X \le 101$
H[1:0]=[0:1]											
Reserved	0	0	0	0	0	0	0	0	1	X	Do not use
Display configuration	0	0	0	0	0	0	1	DO	X	X	Top/bottom row mode set data order
Bias system	0	0	0	0	0	1	0	BS_2	BS_1	BS_0	Sets bias system (BSx)
Set Start line	0	0	0	1	S5	S4	S3	S2	S1	S0	Specify the initial display line to realize vertical scrolling
Set V_{OP}	0	0	1	V_{OP6}	V_{OP5}	V_{OP4}	V_{OP3}	V_{OP2}	V_{OP1}	V_{OP0}	Write V_{OP} to register

INSTRUCTION	A0	WR (R/W)	D7	D6	D5	D4	D3	D2	D1	D0	DESCRIPTION
H[1:0]=[1:0]											
Reserved	0	0	0	0	0	0	0	0	1	X	Do not use
Partial screen mode	0	0	0	0	0	0	0	1	0	PS	Partial screen enable
Partial screen size	0	0	0	0	0	0	1	0	0	WS	Set partial screen size
Display part	0	0	0	0	0	1	0	DP2	DP1	DP0	Set display part for partial screen mode
H[1:0]=[1:1]											
RESET	0	0	0	0	0	0	0	0	1	1	Software reset
Display control	0	0	0	0	0	0	1	FR2	FR1	FR0	Frame rate control
N line inversion	0	0	0	1	0	NL4	NL3	NL2	NL1	NL0	Sets N line inversion
Booster Efficiency &Booster Stage	0	0	1	0	0	1	BE1	BE0	PC1	PC0	Booster Efficiency Set
Reserved	0	0	1	X	X	X	X	X	X	X	Do not use

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Only used in 3-line to read ID

INSTRUCTION	A0	COMMAND BYTE								DESCRIPTION
		D7	D6	D5	D4	D3	D2	D1	D0	
H[1:0]=[1:1]										
Self	0	1	1	0	1	1	0	1	0	Identification:ID1
test/identification	0	1	1	0	1	1	0	1	1	Identification:ID2
Data read	0	1	1	0	1	1	1	0	0	Identification:ID3
	0	1	1	0	1	1	1	0	1	Identification:ID4

SDA_IN and SDA_OUT must be connected together.

9. INSTRUCTION DESCRIPTION
Function Set

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	1	MX	MY	PD	H1	H0

Flag	Description
MX	SEG bi-direction selection MY=0:normal direction (SEG0->SEG101) MY=1:reverse direction (SEG101->SEG0)
MY	COM bi-direction selection MY=0:normal direction (COM0->COM66) MY=1:reverse direction (COM66->COM0)
PD	All LCD outputs at VSS (display off), bias generator and VLCD generator off, VLCD can be disconnected, oscillator off (external clock possible), RAM contents not cleared; RAM data can be written. PD=0:chip is active PD=1:chip is in power down mode
H0.H1	H0.H1 are used to select different instruction block Follow the instruction table

Read status byte

Indicates the internal status of the ST7549

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	1	PD	0	0	D	E	MX	MY	DO

Flag	Description		
PD	PD=0:chip is active PD=1:chip is in power down mode		
D,E	D	E	The bits D and E select the display mode.
	0	0	Display blank
	0	1	All display segments on
	1	0	Normal mode
	1	1	Inverse video mode
DO	DO=0:LSB is on top DO=1:MSB is on top See page 20		

Read data

8-bit data of Display Data from the RAM location specified by the column address and page address can be read to the microprocessor .

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
1	1				Read data				

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Write data

8-bit data of Display Data from the microprocessor can be written to the RAM location specified by the column address and page address. The column address is increased by 1 automatically so that the microprocessor can continuously write data to the addressed page. During auto-increment, the column address wraps to 0 after the last column is written.

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
1	0				Write data				

H[1:0]=[0:0]

Set V$_{LCD}$ range

V$_{LCD}$ range L/H select

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	0	0	1	0	PRS

PRS=0: VLCD programming range LOW

PRS=1: VLCD programming range HIGH

Display Control

This bits D and E selects the display mode.

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	0	1	D	0	E

Flag	Description		
	D	E	The bits D and E select the display mode.
	0	0	Display blank
D,E	1	0	Normal display
	0	1	All display segments on
	1	1	Inverse video mode

Set Y address of RAM

Y [3:0] defines the Y address vector address of the display RAM.

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	1	0	0	Y$_3$	Y$_2$	Y$_1$	Y$_0$

Y$_3$	Y$_2$	Y$_1$	Y$_0$	CONTENT	ALLOWED X-RANGE
0	0	0	0	Page0 (display RAM)	0 to 101
0	0	0	1	Page1 (display RAM)	0 to 101
0	0	1	0	Page2 (display RAM)	0 to 101
0	0	1	1	Page3 (display RAM)	0 to 101
0	1	0	0	Page4 (display RAM)	0 to 101
0	1	0	1	Page5 (display RAM)	0 to 101
0	1	1	0	Page6 (display RAM)	0 to 101
0	1	1	1	Page7 (display RAM)	0 to 101
1	0	0	0	Page8 (display RAM)	0 to 101
1	0	0	1	Page9 (display RAM)	0 to 101

Set X address of RAM

The X address points to the columns. The range of X is 0…101.

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	1	X_6	X_5	X_4	X_3	X_2	X_1	X_0

X_6	X_5	X_4	X_3	X_2	X_1	X_0	Column address
0	0	0	0	0	0	0	0
0	0	0	0	0	0	1	1
0	0	0	0	0	1	0	2
0	0	0	0	0	1	1	3
:	:	:	:	:	:	:	:
1	1	0	0	0	1	0	98
1	1	0	0	0	1	1	99
1	1	0	0	1	0	0	100
1	1	0	0	1	0	1	101

END

This command releases the read/modify/write mode, and returns the column and row address to the address it was at when the mode was entered.

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	0	0	1	1	0

Read/modify/write

This command is used paired with the "END" command. Once this command has been input, the display data read command does not change the column and row address, but only the display data write command increments (+1) the address depend on V register setting. This mode is maintained until the END command is input. When the END command is input, the address returns to the address it was at when the read/modify/write command was entered. This function makes it possible to reduce the load on the MPU when there are repeating data changes in a specified display region, such as when there is a blanking cursor.

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	0	0	1	1	1

* Even in read/modify/write mode, other commands aside from display data read/write commands can also be used.

Page address set

Column address set

Read-modify-write

Dummy read

Data read

Data write

Changes

NO

YES

END
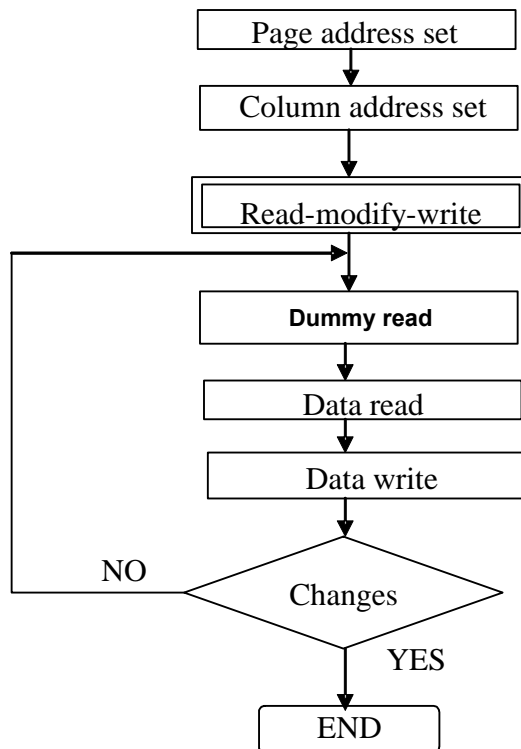
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H[1:0]=[0:1]
Display configuration

Top/bottom row mode set data order

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	0	1	DO	X	X

Flag	Description
DO	DO=0:LSB is on top DO=1:MSB is on top See page 20

System Bias

Select LCD bias ratio of the voltage required for driving the LCD.

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	1	0	BS_2	BS_1	BS_0

BS_2	BS_1	BS_0	Bias	Recommend Duty
0	0	0	11	1:100
0	0	1	10	1:81
0	1	0	9	1:65/1:68
0	1	1	8	1:49
1	0	0	7	1/40:1/36
1	0	1	6	1/24
1	1	0	5	1:18/1:16
1	1	1	4	1:10/1:9/1:8

LCD bias voltage

Symbol	Bias voltage for 1/9 bias	Symbol	Bias voltage for 1/9 bias
VLCD	VLCD	V3	2/9 X VLCD
V1	8/9 X VLCD	V4	1/9 X VLCD
V2	7/9 X VLCD	VSS	VSS

Set start line

Sets the line address of display RAM to determine the initial display line instruction. The RAM display data is displayed at the top of row (COM0) of LCD panel.

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	1	S_5	S_4	S_3	S_2	S_1	S_0

S_5	S_4	S_3	S_2	S_1	S_0	Line address
0	0	0	0	0	0	0
0	0	0	0	0	1	1
0	0	0	0	1	0	2
0	0	0	0	1	1	3
:	:	:	:	:	:	:
1	1	1	1	0	0	61
1	1	1	1	0	1	62
1	1	1	1	1	0	62
1	1	1	1	1	1	63

Set VOP value:

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	1	V_{OP6}	V_{OP5}	V_{OP4}	V_{OP3}	V_{OP2}	V_{OP1}	V_{OP0}

The operation voltage V_{LCD} can be set by software.

$$V_{LCD}=(a + V_{OP} \times b) \tag{1}$$

The parameters are explained in table 4.The maximum voltage that can be generated is depending on the VDD1 voltage and the display load current. Two overlapping VLCD ranges are selectable via the command " Booster control". For the LOW (PS=0) range a=a1 and for the HIGH (PRS=1) range a=a2 with steps equal to " b" in both ranges. Note that the charge pump is turned off if VOP [6;0] and the bit PRS are all set to zero

Table 4 Typical values for parameter for the HV-Generator programming

SYMBOL	VALUE	UNIT
a1	2.94(PRS=0)	V
a2	6.75(PRS=1)	V
b	0.03	V

VOP [6:0](programmed) {00 hex… 7F hex}

Fig.23 V_{OP} programming of ST7549

ST7549
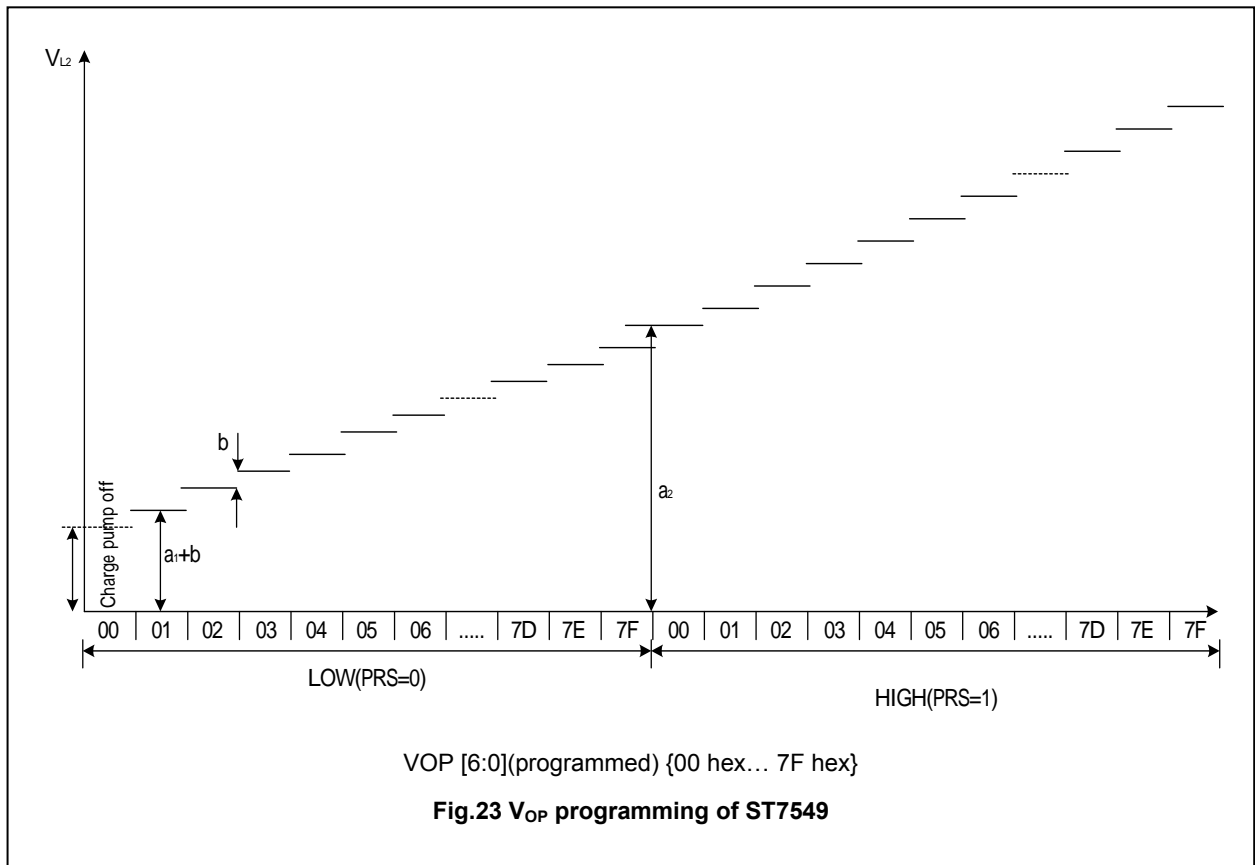
H[1:0]=[1:0]

Partial screen mode

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	0	0	1	0	PS

Flag	Description
PS	Full display mode or partial screen mode selection PS=0:Full display mode with MUX 1:68 PS=1:Partial screen mode with MUX 1:17 or MUX 1:33

When enter Partial screen mode , COMS also works. The DDRAM position of COMS is at page9(D0)

Partial screen size

This instruction can select partial screen size

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	0	1	0	0	WS

Flag	Description
WS	WS=0:partail screen mode with MUX 1:17(16 Common + COMS) WS=1:Partial screen mode with MUX 1:33(32 Common + COMS)

Display part

This instruction can select partial screen modes

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	1	0	DP_2	DP_1	DP_0

Flag	Status			Description	
				Display common	**DDRAM position**
DP_2 DP_1 DP_0	0	0	0	Start from common 0	Start from page 0
	0	0	1	Start from common 8	Start from page 1
	0	1	0	Start from common 16	Start from page 2
	0	1	1	Start from common 24	Start from page 3
	1	0	0	Start from common 32	Start from page 4
	1	0	1	Start from common 40	Start from page 5
	1	1	0	Start from common 48	Start from page 6
	1	1	1	Start from common 56	Start from page 7

The range of display common and DDRAM depends on the "WS" register . For example , if WS=1 and DP[2:0]=001 ,then display common is common 8 to common 39 and DDRAM position is page 1 to page4 and COMS is at page 9 . Moreover the bottom of DP[2:0] is common 66, when the range is over common66,there will be no more common output to display

H[1:0]=[1:1]

Reset

This instruction resets initial display line, column address, page address, and common output status select to their initial status .This instruction cannot initialize the LCD power supply, which is initialized by the RESB pin.

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	0	0	0	1	1

Frame frequency

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	0	1	FR2	FR1	FR0

This command is used to set the frame frequency.

FR_2	FR_1	FR_0	FR frequency
0	0	0	55 Hz ±15%
0	0	1	65 Hz ±15%
0	1	0	68 Hz ±15%
0	1	1	70 Hz ±15%
1	0	0	73 Hz ±10%
1	0	1	76 Hz ±15%
1	1	0	80 Hz ±15%
1	1	1	137 Hz ±15%

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Release N-line inversion

ST7549 returns to the frame inversion condition from the N-line inversion condition.

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	1	0	NL4	NL3	NL2	NL1	NL0

Set N-line inversion

Sets the inverted line number within range of 3 to 33 to improve the display quality by controlling the phase of the internal LCD AC signal (M)

Note: The N-line inversion mode will be disabled when partial display mode enter. After the partial display mode end, the N-line inversion mode will return as it was.

NL4	NL3	NL2	NL1	NL0	Selected n-line inversion
0	0	0	0	0	0-line inversion (frame inversion)
0	0	0	0	1	3-line inversion
0	0	0	1	0	4-line inversion
0	0	0	1	1	5-line inversion
:	:	:	:	:	:
1	1	1	0	1	31-line inversion
1	1	1	1	0	32-line inversion
1	1	1	1	1	33-line inversion

Booster Efficiency & Booster stages

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	1	0	0	1	BE1	BE0	PC1	PC0

Booster Efficiency

The ST7549 incorporates software configurable Booster Efficiency. It could be used with Voltage multiplier to get the suitable Vout and Power consumption .Using lower Booster Efficiency level will get the lower Vout & lower Power consumption. *Default setting is Level 2.(suggest level)*

Flag	Description		
	BE_1	BE_2	
	0	0	Booster Efficiency Level 4
BE[1:0]	0	1	Booster Efficiency Level 3
	1	0	Booster Efficiency Level 2(default)
	1	1	Booster Efficiency Level 1

Booster stages

The ST7549 incorporates a software configurable voltage multiplier. After reset (RESB), the default voltage multiplier is related to "CP" pin(see page 11). Other voltage multiplier factors are set via this command .

Flag	Description		
	PC_1	PC_0	
	0	0	2*voltage multiplier(Booster X2)
PC_1, PC0	0	1	3*voltage multiplier(Booster X3)
	1	0	4*voltage multiplier(Booster X4)
	1	1	5*voltage multiplier(Booster X5)

Self Test/Identification Data Read(Only used under 3-LINE interface)

These command set SDAOUT to Diver TxData-mode and enable to read the status of B1   B4 (ID1   ID4) from output of multiplexer inside the driver.

A0	D7	D6	D5	D4	D3	D2	D1	D0	Description
0	1	1	0	1	1	0	1	0	Read the status of the B1 (ID1)
0	1	1	0	1	1	0	1	1	Read the status of the B2 (ID2)
0	1	1	0	1	1	1	0	0	Read the status of the B3 (ID3)
0	1	1	0	1	1	1	0	1	Read the status of the B4 (ID4)

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10. COMMAND DESCRIPTION

Referential Instruction Setup Flow: Initializing with the built-in Power Supply Circuits

```
┌─────────────────────────────────────┐
│  User System Setup by External Pins  │
└─────────────────────────────────────┘
                  │
                  ▼
┌─────────────────────────────────────┐
│        Start of Initialization        │
└─────────────────────────────────────┘
                  │
                  ▼
┌─────────────────────────────────────┐
│ Power ON(VDD-VSS) Keeping the /RESB Pin="L" │
└─────────────────────────────────────┘
                  │
                  ▼
┌─────────────────────────────────────┐
│    Waiting for Stabilizing the Power  │
└─────────────────────────────────────┘
                  │
                  ▼
┌─────────────────────────────────────┐
│   Release the reset state. (/RESB pin="H")  │
│   Waiting reset circuit stablized(>1ms)     │
└─────────────────────────────────────┘
                  │
                  ▼
┌─────────────────────────────────────┐
│                                       │
│     Function set PD=0,H1=0,H0=1       │
│          SET Bias system              │
│              SET D0                    │
│              SET VOP                   │
│     Function set PD=0,H1=0, H0=0      │
│          Set VLCD Range(PRS)           │
│     Display control D=1 E=0 (Normal)  │
│           Set X , Y address            │
│                                       │
└─────────────────────────────────────┘
                  │
                  ▼
┌─────────────────────────────────────┐
│        End of Initialization          │
└─────────────────────────────────────┘
```
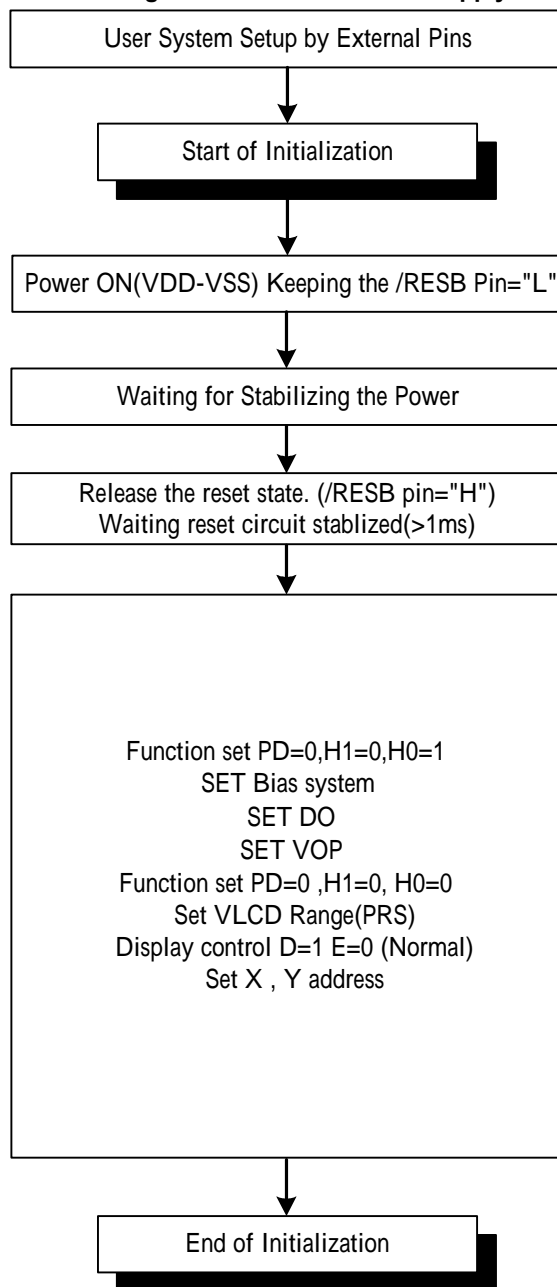
Fig.24 Initializing with the Built-in Power Supply Circuits

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11. LIMITING VALUES

In accordance with the Absolute Maximum Rating System; see notes 1 and 2.

Parameter	Symbol	Conditions	Unit
Power Supply Voltage	VDD1	-0.5 ~ 5	V
Power supply voltage	VDD2	-0.5 ~ 5	V
Power supply voltage (VDD standard)	VLCDIN	4.5~13	V
Power supply voltage (VDD standard)	V1, V2, V3, V4	0.3 to Vlcdin	V
Input voltage	CSB,RESB,A0,/WR,/RD,D7~D0	-0.5 ~ 5	V
Operating temperature	TOPR	–40 to +85	°C
Storage temperature	TSTR	–65 to +150	°C

System (MPU) side   ST7549 chip side
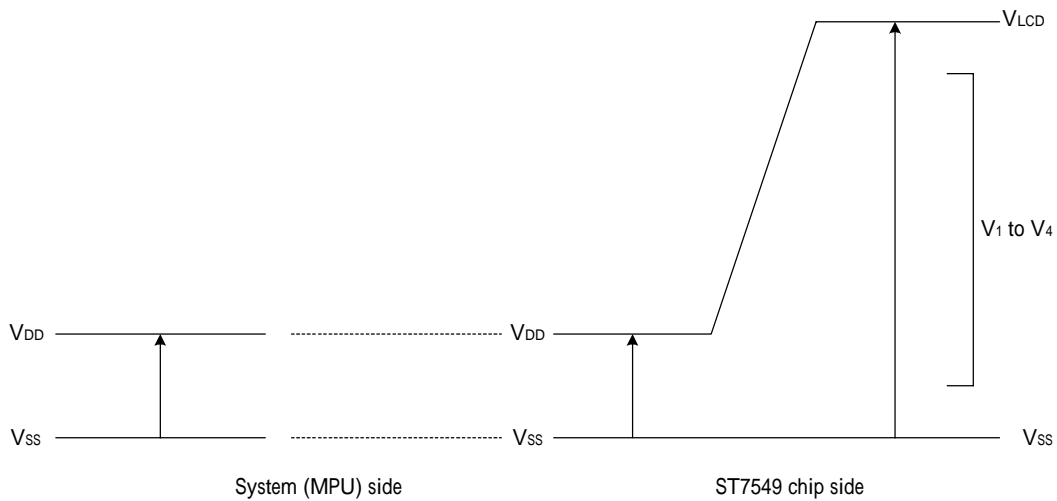
Notes

1. Stresses above those listed under Limiting Values may cause permanent damage to the device.

2. Parameters are valid over operating temperature range unless otherwise specified. All voltages are with respect to V_{SS} unless otherwise noted.

3. Insure that the voltage levels of V1, V2, V3, and V4 are always such that

   VLCDIN   V0   V1   V2   V3   V4   Vss

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12. HANDLING

Inputs and outputs are protected against electrostatic discharge in normal handling. However, to be totally safe, it is desirable to take normal precautions appropriate to handling MOS devices (see "Handling MOS devices").

13. DC CHARACTERISTICS

V_{DD1} = 1.7 V to 3.3V; V_{SS} = 0 V; Vout = 3.0 to 13.0V; T_{amb} = -40 to +85 ; unless otherwise specified.

Item	Symbol	Condition		Rating			Units	Applicable Pin
				Min.	Typ.	Max.		
Operating Voltage (1)	VDD1			1.7	—	3.3	V	Vss
Operating Voltage (2)	VDD2	(Relative to VSS)		2.4	—	3.3	V	VSS
High-level Input Voltage	VIHC			0.7 x VDD	—	VDD	V	
Low-level Input Voltage	VILC			VSS	—	0.3 x VDD	V	
High-level Output Voltage	VOHC			0.7 x VDD	—	VDD	V	
Low-level Output Voltage	VOLC			VSS	—	0.3 x VDD	V	
Input leakage current	ILI			–1.0	—	1.0	μ A	
Output leakage current	ILO			–3.0	—	3.0	μ A	
Liquid Crystal Driver ON Resistance	RON	Ta = 25°C (Relative To VSS)	VLCDIN = 13.0 V	—	2.0	—	K	SEGn COMn *6
			VLCDIN = 8.0 V	—	3.2	—		
Frame frequency	FR			—	73	—	Hz	

	Item	Symbol	Condition	Rating			Units	Applicable Pin
				Min.	Typ.	Max.		
Internal Power	Input voltage	VDD1	(Relative To VSS)	1.7	—	3.3	V	
	Supply Step-up output voltage Circuit	VLCDOUT	(Relative To VSS)	—	—	13	V	VLCDOUT
	Voltage regulator Circuit Operating Voltage	VLCDIN	(Relative To VSS)	—	—	13	V	VLCDIN

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Dynamic Consumption Current : During Display, with the Internal Power Supply ON Current consumed by total ICs(bare die)

Test pattern	Symbol	Condition	Rating			Units	Notes
			Min.	Typ.	Max.		
Display Pattern SNOW	ISS	VDD = 3.0 V, Booster X4 V0 – VSS = 9.0 V	—	300	—	μ A	
Power Down	ISS	Ta = 25°C	—	0.01	2	μ A	

Notes to the DC characteristics

1. The maximum possible V_{LCD} voltage that may be generated is dependent on voltage, temperature and (display) load.

2. Internal clock

3. Power-down mode. During power down all static currents are switched off.

4. If external V_{LCDIN}, the display load current is not transmitted to I_{DD}.

5. V_{OUT} external voltage applied to VLCDIN pin; VLCDIN disconnected from VLCDOUT (no connect)

14. TIMING CHARACTERISTICS

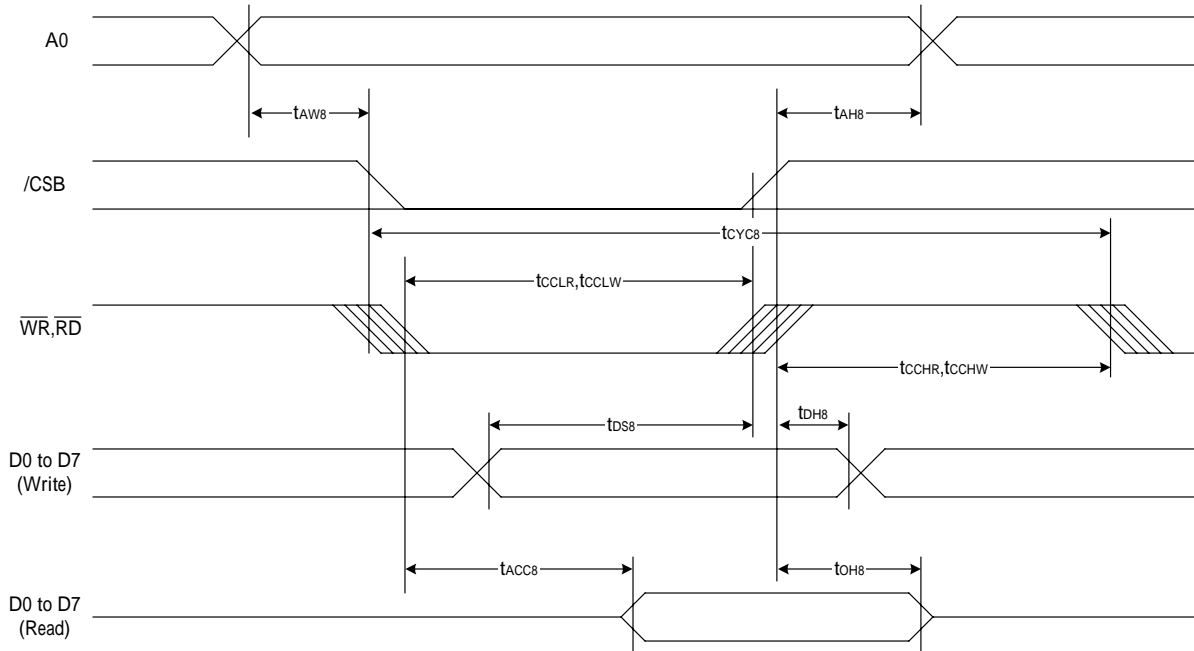**System Bus Read/Write Characteristics 1 (For the 8080 Series MPU)**

Figure 26.

(VDD = 3.3V , Ta =25°C)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	**Max.**	
Address hold time		tAH8		10	—	
Address setup time	A0	tAW8		100	—	
System cycle time		tCYC8		400	—	
Enable L pulse width (WRITE)	WR	tCCLW		80	—	
Enable H pulse width (WRITE)		tCCHW		80	—	
Enable L pulse width (READ)	RD	tCCLR		140	—	ns
Enable H pulse width (READ)		tCCHR		80		
WRITE Data setup time		tDS8		80	—	
WRITE Address hold time	D0 to D7	tDH8		10	—	
READ access time		tACC8	CL = 100 pF	—	70	
READ Output disable time		tOH8	CL = 100 pF	5	50	

(VDD = 2.7 V , Ta = 25°C)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Address hold time	A0	tAH8		15	—	ns
Address setup time		tAW8		150	—	
System cycle time		tCYC8		600	—	
Enable L pulse width (WRITE)	WR	tCCLW		220	—	
Enable H pulse width (WRITE)		tCCHW		180	—	
Enable L pulse width (READ)	RD	tCCLR		220	—	
Enable H pulse width (READ)		tCCHR		180	—	
WRITE Data setup time	D0 to D7	tDS8		120	—	
WRITE Address hold time		tDH8		15	—	
READ access time		tACC8	CL = 100 pF	—	140	
READ Output disable time		tOH8	CL = 100 pF	10	100	

(VDD = 1.8V , Ta = 25°C)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Address hold time	A0	tAH8		30	—	ns
Address setup time		tAW8		200	—	
System cycle time		tCYC8		1000	—	
Enable L pulse width (WRITE)	WR	tCCLW		360	—	
Enable H pulse width (WRITE)		tCCHW		280	—	
Enable L pulse width (READ)	RD	tCCLR		360	—	
Enable H pulse width (READ)		tCCHR		280		
WRITE Data setup time	D0 to D7	tDS8		200	—	
WRITE Address hold time		tDH8		30	—	
READ access time		tACC8	CL = 100 pF	—	240	
READ Output disable time		tOH8	CL = 100 pF	10	200	

*1 The input signal rise time and fall time (tr, tf) is specified at 15 ns or less. When the system cycle time is extremely fast,

(tr +tf)   (tCYC8 – tCCLW – tCCHW) for (tr + tf)   (tCYC8 – tCCLR – tCCHR) are specified.

*2 All timing is specified using 20% and 80% of VDD as the reference.

*3 tCCLW and tCCLR are specified as the overlap between CSB being "L" and WR and RD being at the "L" level.

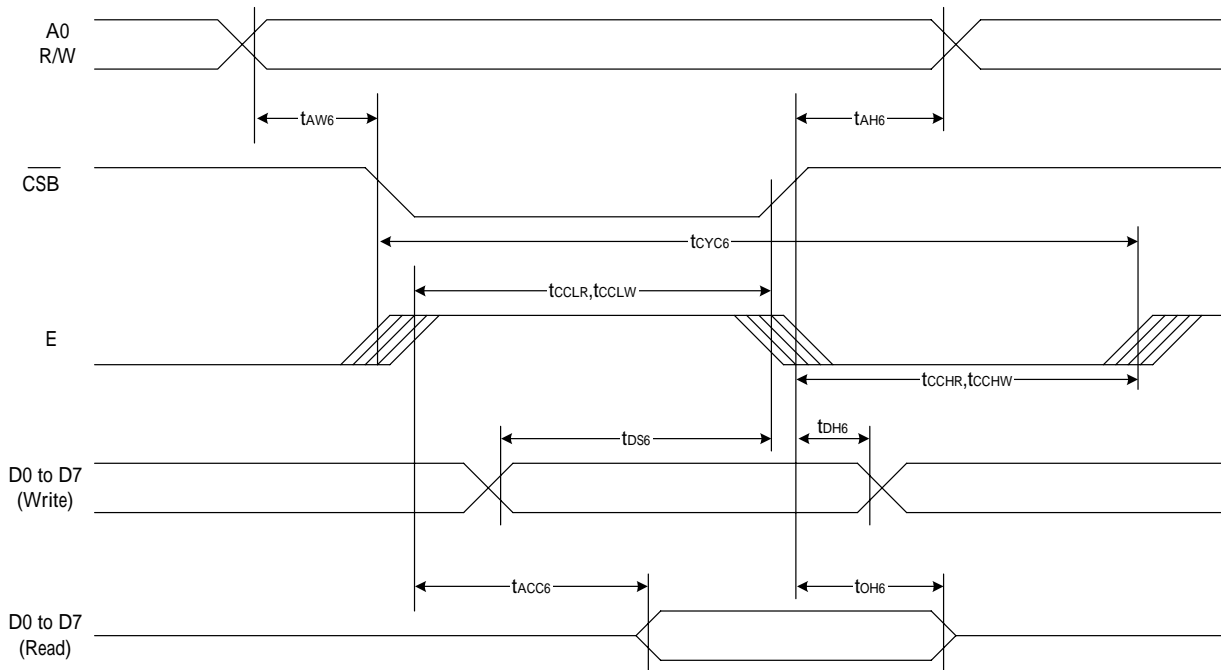**System Bus Read/Write Characteristics 1 (For the 6800 Series MPU)**

Figure 27.

(V_{DD} = 3.3 V , Ta = 25°C)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	**Max.**	
Address hold time	A0	tAH6		10	—	
Address setup time		tAW6		0	—	
System cycle time		tCYC6		240	—	
Enable L pulse width (WRITE)	WR	tEWLW		80	—	
Enable H pulse width (WRITE)		tEWHW		80	—	
Enable L pulse width (READ)	RD	tEWLR		80	—	ns
Enable H pulse width (READ)		tEWHR		140		
WRITE Data setup time	D0 to D7	tDS6		80	—	
WRITE Address hold time		tDH6		10	—	
READ access time		tACC6	CL = 100 pF	—	70	
READ Output disable time		tOH6	CL = 100 pF	5	50	

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Item	Signal	Symbol	Condition	Rating Min.	Rating Max.	Units
Address hold time	A0	tAH6		15	—	ns
Address setup time		tAW6		0	—	
System cycle time		tCYC6		400	—	
Enable L pulse width (WRITE)	WR	tEWLW		220	—	
Enable H pulse width (WRITE)		tEWHW		180	—	
Enable L pulse width (READ)	RD	tEWLR		220	—	
Enable H pulse width (READ)		tEWHR		180	—	
WRITE Data setup time	D0 to D7	tDS6		120	—	
WRITE Address hold time		tDH6		15	—	
READ access time		tACC6	CL = 100 pF	—	140	
READ Output disable time		tOH6	CL = 100 pF	10	100	

Item	Signal	Symbol	Condition	Rating Min.	Rating Max.	Units
Address hold time	A0	tAH6		30	—	ns
Address setup time		tAW6		0	—	
System cycle time		tCYC6		640	—	
Enable L pulse width (WRITE)	WR	tEWLW		360	—	
Enable H pulse width (WRITE)		tEWHW		280	—	
Enable L pulse width (READ)	RD	tEWLR		360	—	
Enable H pulse width (READ)		tEWHR		280	—	
WRITE Data setup time	D0 to D7	tDS6		200	—	
WRITE Address hold time		tDH6		30	—	
READ access time		tACC6	CL = 100 pF	—	240	
READ Output disable time		tOH6	CL = 100 pF	10	200	

*1 The input signal rise time and fall time (tr, tf) is specified at 15 ns or less. When the system cycle time is extremely fast,

(tr +tf)   (tCYC6 – tEWLW – tEWHW) for (tr + tf)   (tCYC6 – tEWLR – tEWHR) are specified.

*2 All timing is specified using 20% and 80% of VDD as the reference.

*3 tEWLW and tEWLR are specified as the overlap between CSB being "L" and E.
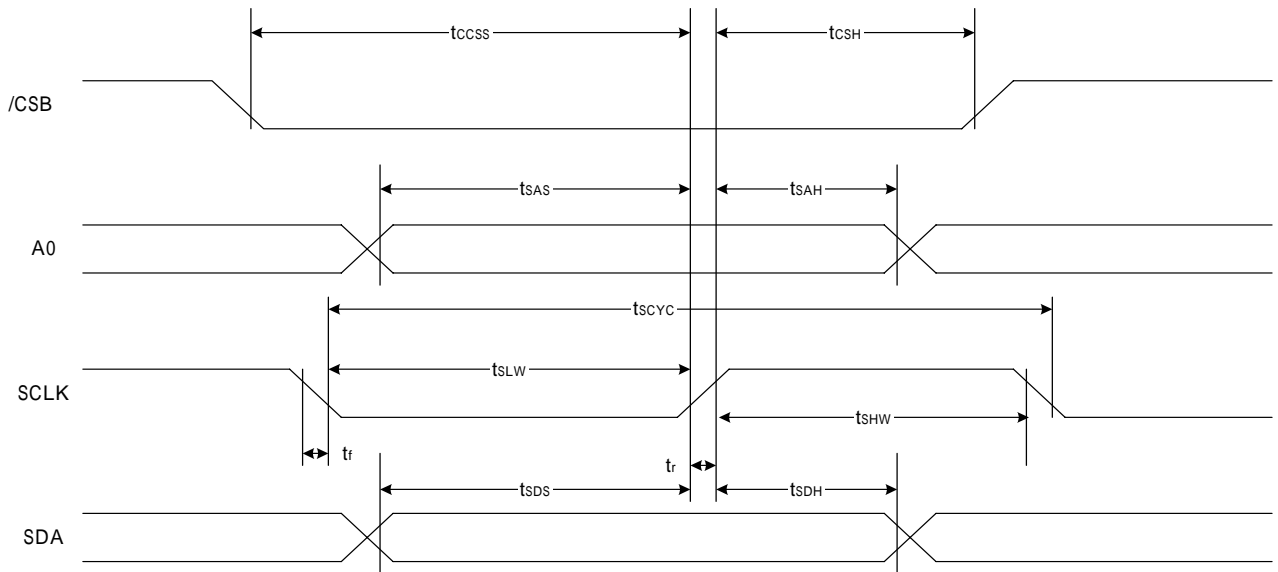
SERIAL INTERFACE(4-Line Interface)

Fig 28.

(V_{DD}=3.3V,Ta=25)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	**Max.**	
Serial Clock Period		tSCYC		150	—	
SCL "H" pulse width	SCL	tSHW		75	—	
SCL "L" pulse width		tSLW		75	—	
Address setup time	A0	tSAS		20	—	
Address hold time		tSAH		100	—	ns
Data setup time	SI	tSDS		20	—	
Data hold time		tSDH		10	—	
CS-SCL time	CSB	tCSS		20	—	
CS-SCL time		tCSH		140	—	

(V_{DD}=2.7V,Ta=25)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	**Max.**	
Serial Clock Period		tSCYC		300	—	
SCL "H" pulse width	SCL	tSHW		150	—	
SCL "L" pulse width		tSLW		150	—	
Address setup time	A0	tSAS		30	—	
Address hold time		tSAH		150	—	ns
Data setup time	SI	tSDS		30	—	
Data hold time		tSDH		20	—	
CS-SCL time	CSB	tCSS		30	—	
CS-SCL time		tCSH		200	—	

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(V$_{DD}$=1.8V,Ta=25　)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	**Max.**	
Serial Clock Period	SCL	tSCYC		500	—	ns
SCL "H" pulse width		tSHW		250	—	
SCL "L" pulse width		tSLW		250	—	
Address setup time	A0	tSAS		60	—	
Address hold time		tSAH		250	—	
Data setup time	SI	tSDS		60	—	
Data hold time		tSDH		50	—	
CS-SCL time	CSB	tCSS		40	—	
CS-SCL time		tCSH		350	—	

*1 The input signal rise and fall time (tr, tf) are specified at 15 ns or less.

*2 All timing is specified using 20% and 80% of VDD as the standard.
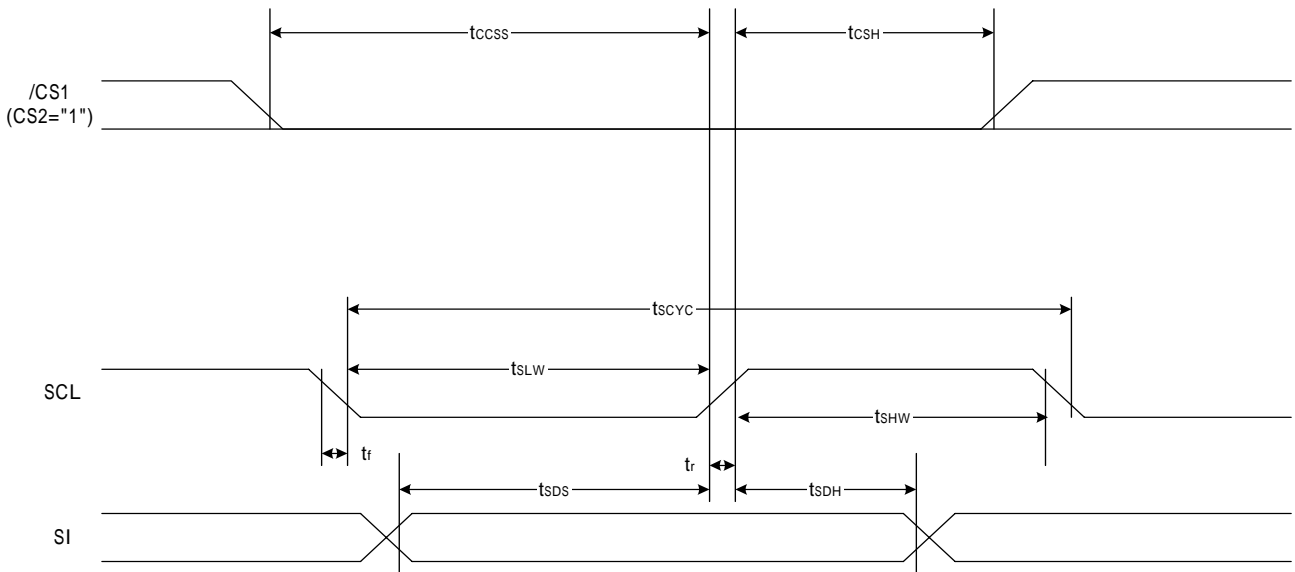
ST7549

SERIAL INTERFACE(3-Line Interface)

Fig 28.

(V_{DD}=3.3V,Ta=25)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	**Max.**	
Serial Clock Period	SCL	tSCYC		150	—	ns
SCL "H" pulse width		tSHW		75	—	
SCL "L" pulse width		tSLW		75	—	
Data setup time	SI	tSDS		20	—	
Data hold time		tSDH		10	—	
CS-SCL time	CSB	tCSS		20	—	
CS-SCL time		tCSH		140	—	

(V_{DD}=2.7V,Ta=25)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	**Max.**	
Serial Clock Period	SCL	tSCYC		300	—	ns
SCL "H" pulse width		tSHW		150	—	
SCL "L" pulse width		tSLW		150	—	
Data setup time	SI	tSDS		30	—	
Data hold time		tSDH		20	—	
CS-SCL time	CSB	tCSS		30	—	
CS-SCL time		tCSH		200	—	

(V$_{DD}$=1.8V,Ta=25)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Serial Clock Period	SCL	tSCYC		500	—	ns
SCL "H" pulse width		tSHW		250	—	
SCL "L" pulse width		tSLW		250	—	
Data setup time	SI	tSDS		60	—	
Data hold time		tSDH		50	—	
CS-SCL time	CSB	tCSS		40	—	
CS-SCL time		tCSH		350	—	

*1 The input signal rise and fall time (tr, tf) are specified at 15 ns or less.

*2 All timing is specified using 20% and 80% of VDD as the standard.

SERIAL INTERFACE(I^{2}C Interface)
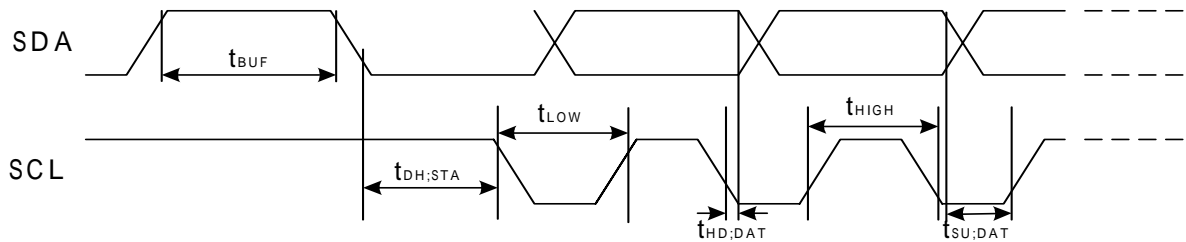
(V$_{DD}$=3.3V,Ta=25)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
SCL clock frequency	SCL	FSCLK		-	400	kHZ
SCL clock low period	SCL	TLOW		1.3	-	us
SCL clock high period	SCL	THIGH		0.6	-	us
Data set-up time	SI	TSU;Data		100	-	ns
Data hold time	SI	THD;Data		0	0.9	us
SCL,SDA rise time	SCL	TR		20+0.1Cb	300	ns
SCL,SDA fall time	SCL	TF		20+0.1Cb	300	ns
Capacitive load represented by each bus line		Cb		-	400	pF
Setup time for a repeated START condition	SI	TSU;SUA		0.6	-	us
Start condition hold time	SI	THD;STA		0.6	-	us
Setup time for STOP condition		TSU;STO		0.6	-	us
Tolerable spike width on bus		TSW		-	50	ns
BUS free time between a STOP and START condition	SCL	TBUF		1.3		us

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15. RESET TIMING
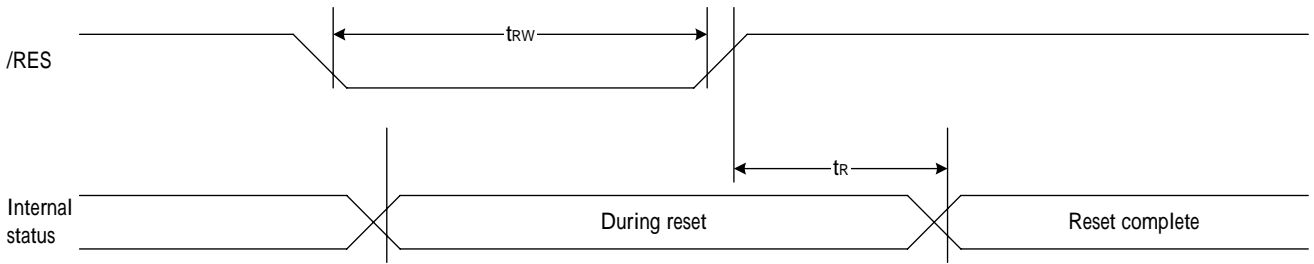
Fig 29.

(VDD = 3.3V , Ta = –40 to 85°C)

Item	Signal	Symbol	Condition	Rating			Units
				Min.	**Typ.**	**Max.**	
Reset time		tR		—	—	1	us
Reset "L" pulse width	RESB	tRW		1	—	—	us

(VDD = 2.7V , Ta = –40 to 85°C)

Item	Signal	Symbol	Condition	Rating			Units
				Min.	**Typ.**	**Max.**	
Reset time		tR		—	—	2.0	us
Reset "L" pulse width	RESB	tRW		2.0	—	—	us

(VDD = 1.8V , Ta = –40 to 85°C)

Item	Signal	Symbol	Condition	Rating			Units
				Min.	**Typ.**	**Max.**	
Reset time		tR		—	—	3.0	us
Reset "L" pulse width	RESB	tRW		3.0	—	—	us

APPLICATION NOTE

ST7549

Resolution : 68(67COM+ICON)*102(SEG)
Interface : 6800 series
Internal analog circuit
Internal OSC
Booster : X5
Bias ratio default : 1/9
(bias ratio can be changed by instruction)
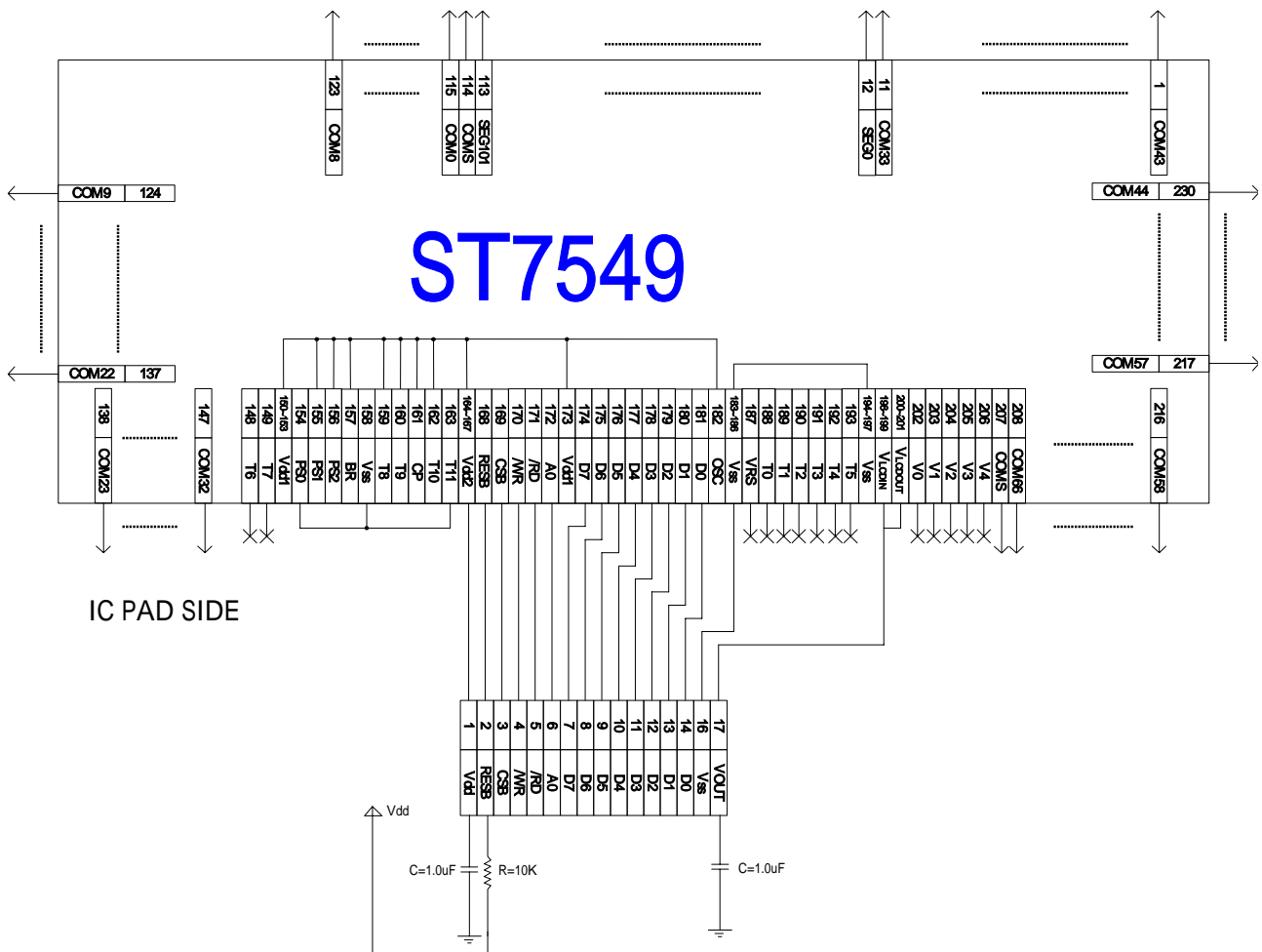C=1.0uF   R=10K

OSC : Vdd
T8 : Vdd
T9 : Vdd
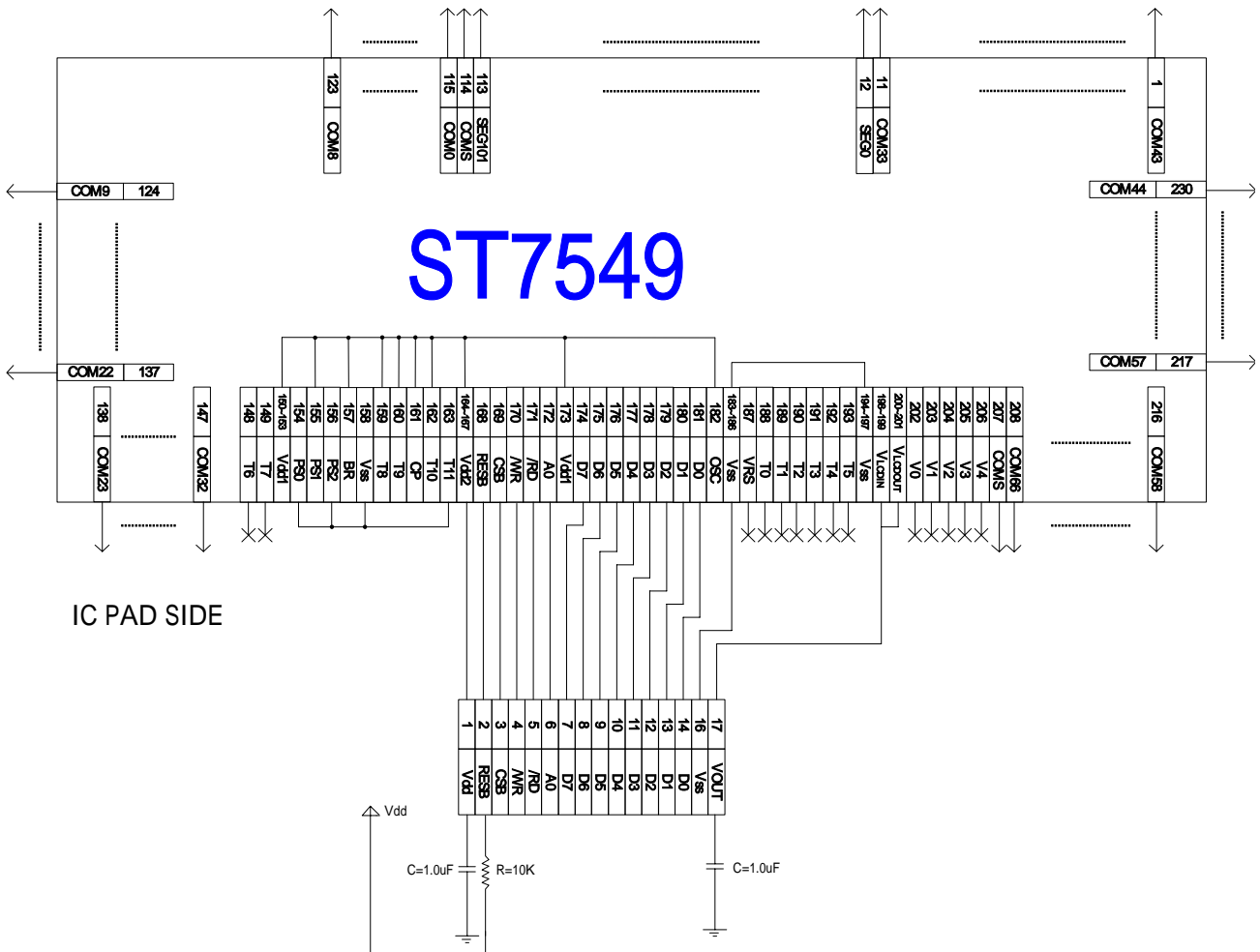T10 : Vdd
T11 : Vss
PS0 : Vss
PS1 : Vdd
PS2 : Vdd
CP : Vdd
BR : Vdd

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IC PAD SIDE

ST7549

Resolution : 68(67COM+ICON)*102(SEG)
Interface : 8080 series
Internal analog circuit
Internal OSC
Booster : X5
Bias ratio default : 1/9
(bias ratio can be changed by instruction)
C=1.0 uF

OSC : Vdd
T8 : Vdd
T9 : Vdd
T10 : Vdd
T11 : Vss
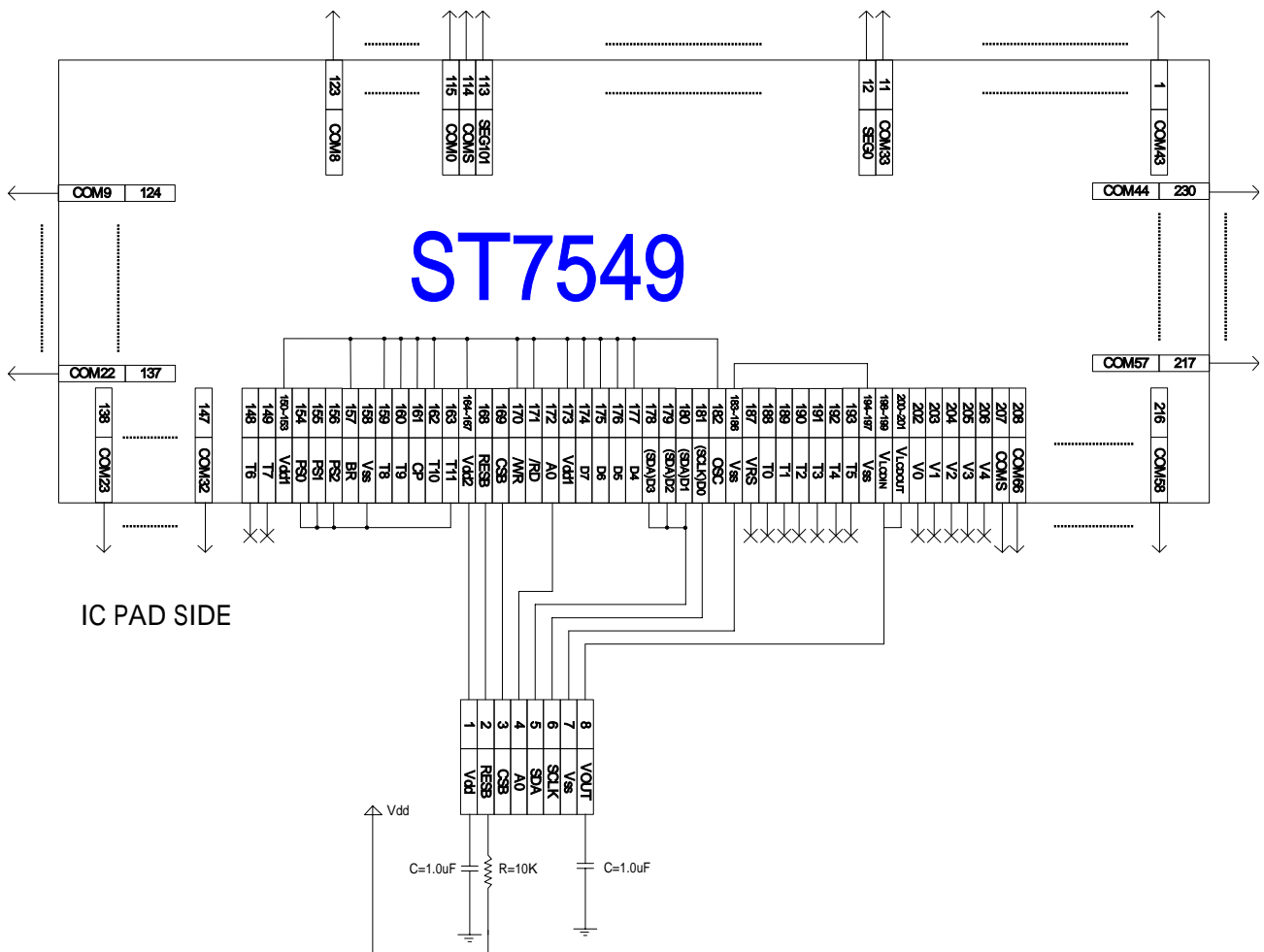PS0 : Vss
PS1 : Vdd
PS2 : Vss
CP : Vdd
BR : Vdd

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IC PAD SIDE

ST7549

Resolution : 68(67COM+ICON)*102(SEG)
Interface : 4-line
Internal analog circuit
Internal OSC
Booster : X5
Bias ratio default : 1/9
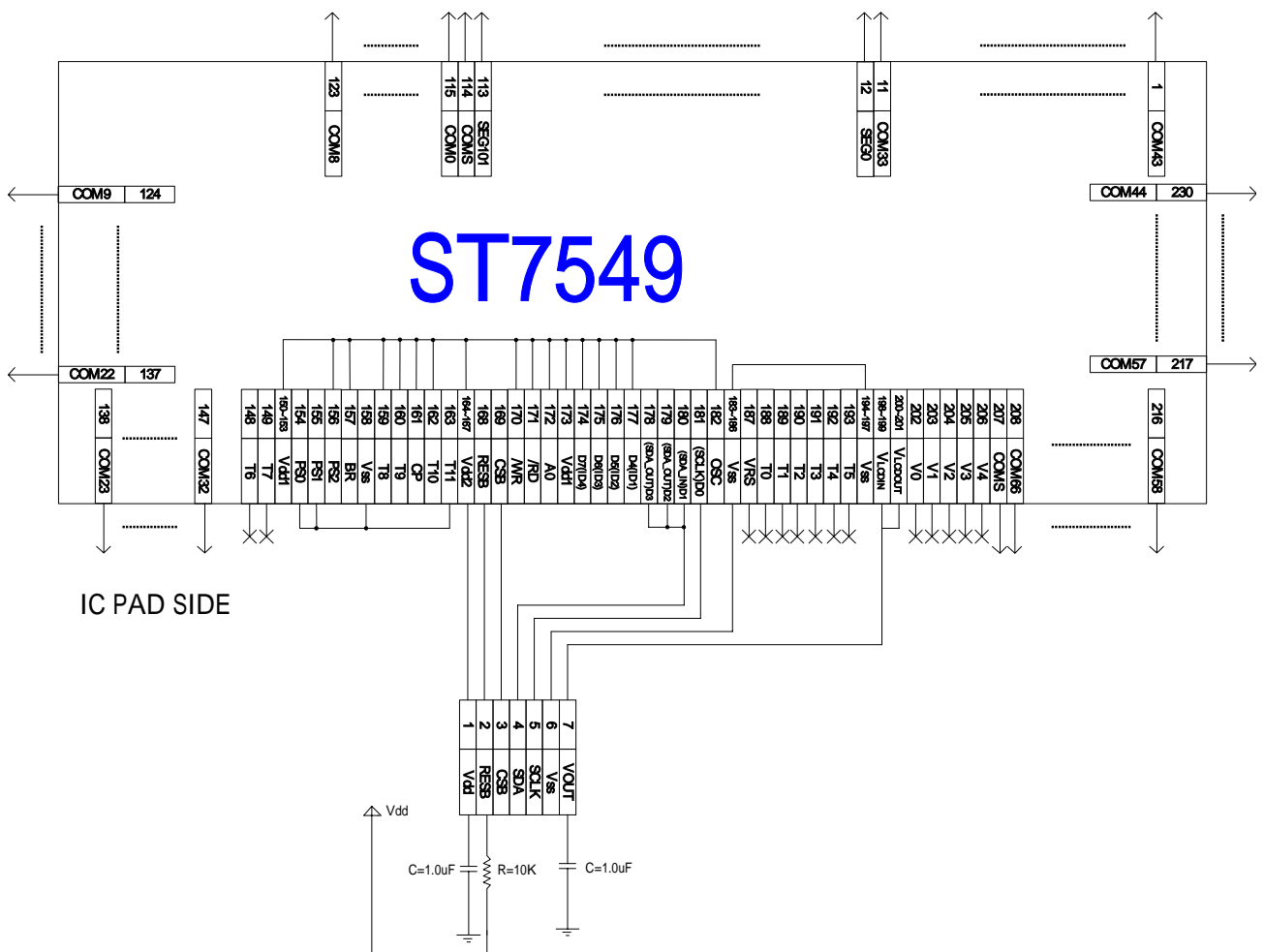(bias ratio can be changed by instruction)
C=1.0uF R=10K

OSC : Vdd
T8 : Vdd
T9 : Vdd
T10 : Vdd
T11 : Vss
PS0 : Vss
PS1 : Vss
PS2 : Vss
CP : Vdd
BR : Vdd

IC PAD SIDE

ST7549

Resolution : 68(67COM+ICON)*102(SEG)
Interface : 3-line
Internal analog circuit
Internal OSC
Booster : X5
Bias ratio default : 1/9
(bias ratio can be changed by instruction)
C=1.0uF   R=10K

OSC : Vdd
T8 : Vdd
T9 : Vdd
T10 : Vdd
T11 : Vss
PS0 : Vss
PS1 : Vss
PS2 : Vdd
CP : Vdd
BR : Vdd
(ID1,ID2,ID3,ID4)=(1,1,1,1)

IC PAD SIDE

C=1.0uF   R=10K   C=1.0uF

Vdd

ST7549

Resolution : 68(67COM+ICON)*102(SEG) OSC : Vdd
Interface : I2C   T8 : Vdd
Internal analog circuit   T9 : Vdd
Internal OSC   T10 : Vdd
Booster : X5   T11 : Vss
Bias ratio default : 1/9   PS0 : Vdd
(bias ratio can be changed by instruction) PS1 : Vdd
SA[1:0]:=(0,0)   PS2 : Vdd
(SA[1:0] are slave address of I2C)   CP : Vdd
C=1.0uF R=10K   BR : Vdd

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IC PAD SIDE

Vdd

R=10K
C=1.0uF   C=1.0uF